






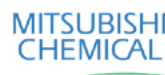















Organic Field-Effect Transistors and Electronics

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University of Michigan - Ann Arbor
<http://www.eecs.umich.edu/omelab>

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- Interface and morphology control

Electrical performance of polymers and small molecules

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- Environmental
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OFET-Based Circuits

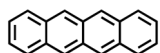
Conclusions



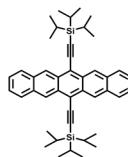
Introduction: Small Molecule Organic Semiconductors

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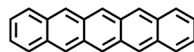
- Polycrystalline films, crystals on micrometer scale.
- Charge densities confined to either a single molecule, or a group of molecules.
- Charge transport characterized by phonon-assisted hopping/tunneling.
- Examples:



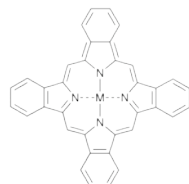
Tetracene



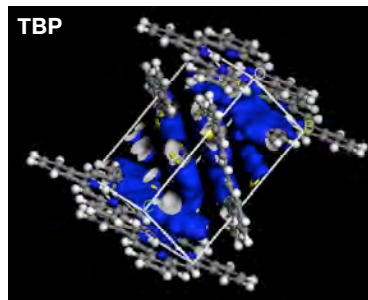
TIPS Pentacene



Pentacene



Metallotetrabenzoporphyrin (MTBP)

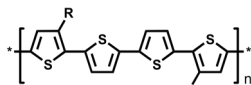


Introduction: Polymer Organic Semiconductors

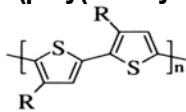
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- Amorphous films, or polycrystalline on a submicrometer scale.
- Charge densities confined to either a single polymer, or a group of polymers chains.
- Charge transport characterized by phonon-assisted hopping/tunneling.
- Examples:

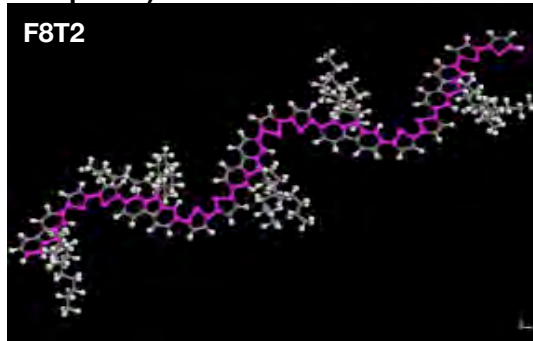
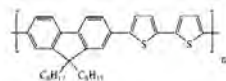
PQT-12 (poly(3,3''-dialkylquaterthiophene))



P3HT (poly(3-hexylthiophene))



F8T2 - (dioctylfluorene co-bithiophene)

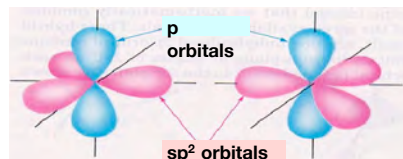


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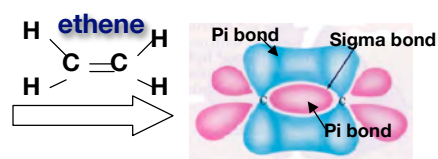
Introduction: Why Conjugated Molecules Can Be Semiconductors

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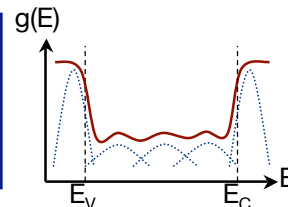
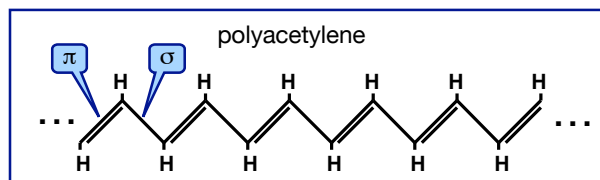
- Atomic orbitals (s , p_x and p_y) hybridize to form hybrid orbitals (sp^2) and p_z .
- Overlap of atomic p_z orbitals form a π -electron system...delocalized along molecule.
- Molecular orbitals interact via weak van der Waal forces to form narrow transport bands at the Highest Occupied and Lowest Unoccupied Molecular Orbital energy levels as well as a HOMO-LUMO energy gap.



sp^2 carbon + sp^2 carbon



C-C double bond/ π -bond



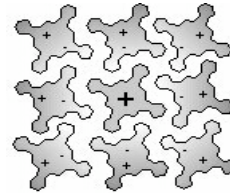
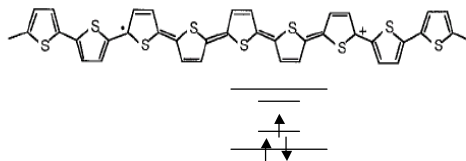
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Polarons

- Carrier lowers energy by distorting lattice
- Strong charge-lattice interaction leads to self-localization
- Polarons, which appear as midgap states, decrease mobility
 - Levels have been demonstrated by UV-vis spectroscopy

p-type polaron in polythiophene



UCSB

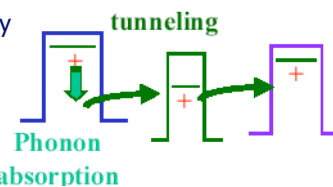
Energy band

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Phonon-Assisted Tunneling/ Hopping Transport

- Charge transport occurs through a hopping mechanism

- Phonons help e⁻'s hop, therefore increasing mobility
- $\mu \downarrow$ as $T \uparrow$ for low temp crystals
- $\mu \uparrow$ as $T \uparrow$ for RT crystals and disordered systems
- Boundary between 0.1 and 1 cm²/V-s



$$W_{ij} = v_0 \exp(-2\Gamma R_{ij}) \begin{cases} \exp\left(-\frac{\epsilon_i - \epsilon_j}{k_B T}\right) & \epsilon_i > \epsilon_j \\ 1 & \epsilon_i < \epsilon_j \end{cases}$$

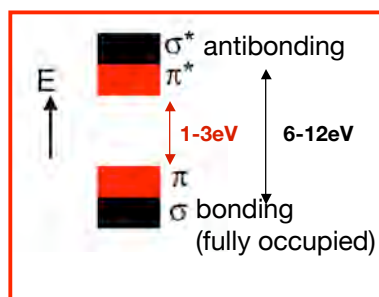
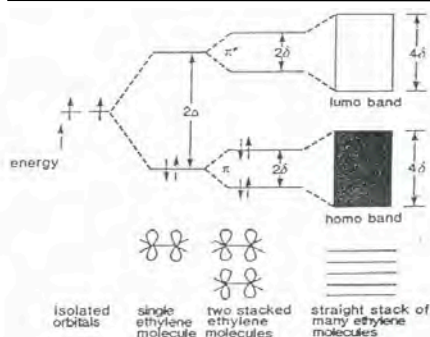
Tunneling
Phonon frequency
Boltzman factor (phonon absorption)

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Introduction: Organic Semiconductor Band Picture

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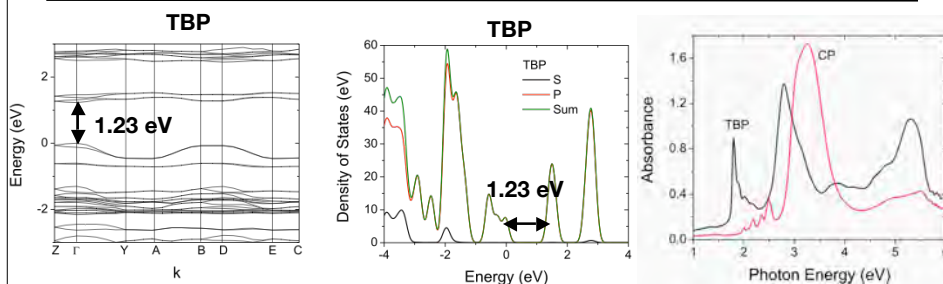


- π electrons are:
 - Delocalized and most easily excited
- $\pi - \pi^*$ transitions equivalent to energy bandgap
- π -bond interactions (p_z orbital overlap) between molecules are critical in organic solid-state electronic devices.



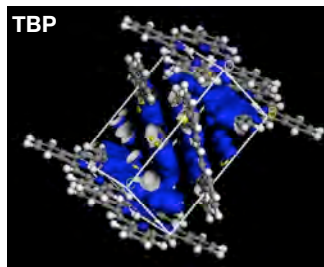
Introduction: Example Organic Energy Band Diagram

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- Flat bandstructure
- Gaussian-shaped bands with narrow bandwidth
- Narrow absorption spectra

- TBP: Tetrabenzoporphyrin



Thin-Film Transistor Structures

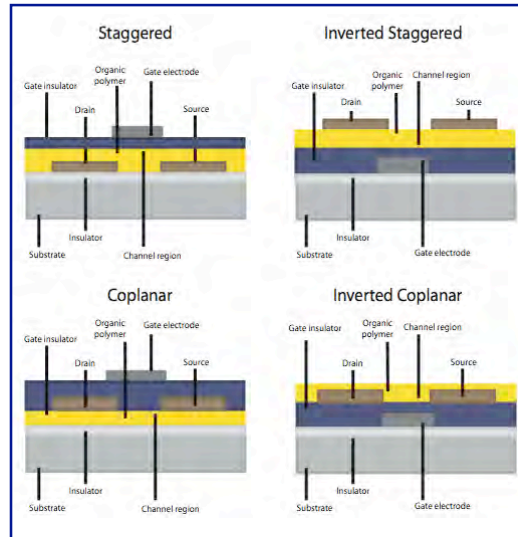
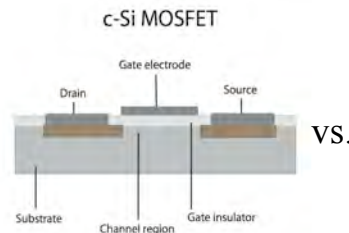
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TFT = FET with a thin film as the active layer (as opposed to device built from bulk).

Fabrication advantages:

- deposited active layer
- wide range of substrates

Various TFT structures

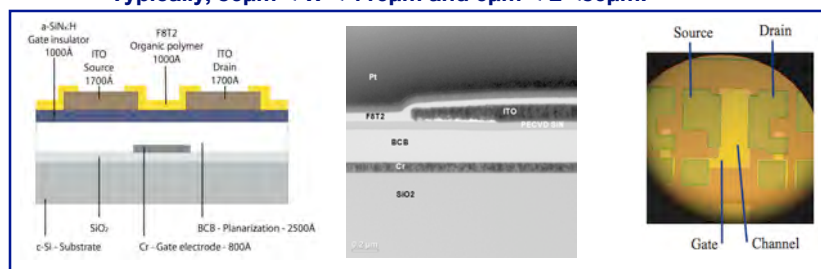


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Example Device Structure

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- Patterned gate electrode (Cr) on Si/SiO₂ carrier substrate.
- Benzocyclobutene (BCB, organic) gate planarization/insulator layer.
- Amorphous, hydrogenated silicon nitride (a-Si_x:H) gate insulator.
- Indium tin oxide (ITO) source and drain electrodes.
- F8T2 active layer (solution deposited, unpatterned).
- Typically, 56μm < W < 116μm and 6μm < L < 56μm.



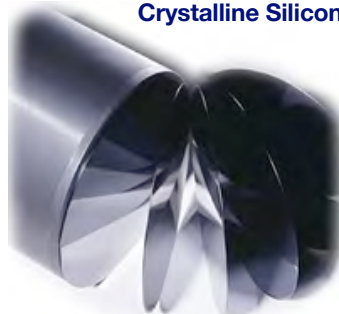
* S. Martin, J. Y. Nahm and J. Kanicki, "Gate-planarized organic polymer thin-film transistors," *Journal of Electronic Materials*, vol. 31, pp. 512-519, 2002.

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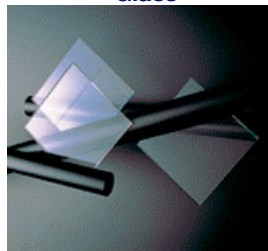
Examples of Rigid and Flexible Substrates

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Crystalline Silicon



Glass



	Appear™	Teonex®	OPS
Thermal Properties			
T _g	330°C	121°C	330°C
T _m	360°C	269°C	330°C
CTE	74		
Optical Properties			
Transmission	91.6%	82.0%	93%
Haze		14.0%	0.40%
Refractive Index	1.52	1.76	1.47
Retardation (100µm-thick film)	< 10nm		< 10nm

- Appear™ by Ferrania Imaging Technologies
- Teonex® by Dupont Teijin film
- OPS by Tosoh Corp

Appear™ substrate appears to be suitable for organic electronics.

Source, Drain, and Gate Electrodes

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Metals:

- Au, Al, Ag, Cr, and heavily doped Si

Metal Conductive Oxides:

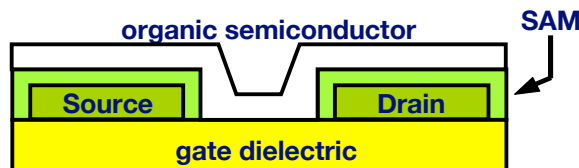
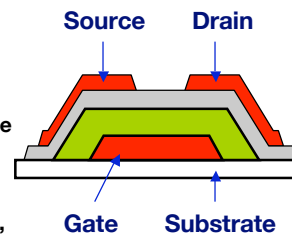
- Indium Tin Oxide (ITO), Aluminum-doped Zinc Oxide (AZO)

Conductive Organic Molecules:

- Polyaniline (PANI), Polyaniline/Nanotube (PANI/NT), poly(3,4-ethylenedioxythiophene)-poly(styrenesulfonate) (PEDOT-PSS)

To be considered:

- Work function matching with organic semiconductor
- Resistance to oxidation
- Processing compatibility and adhesion
- S/D modification by self-assembled monolayer (SAM)
- High conductivity

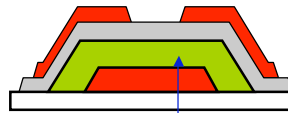


Gate Insulator Dielectrics

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Inorganic

- SiO ₂	ε=3.9
- Al ₂ O ₃	11.5
- SiN _x	7
- TaO ₅	11.6
- TiO ₂	41
- Ba _{0.7} Sr _{0.3} TiO ₃	16



Gate insulator

C. Dimitrakopoulos et al., *Adv. Mater.*, 11, 1372, 1999.

Organic

- Polyimides (PI)	ε=3.4	Kato, et al., <i>Appl. Phys. Lett.</i> 2004, 84, 3789
- Poly(4-vinyl phenyl) (PVP)	4.5	Veres et al, <i>Chem. Mat.</i> 2004, 16, 4543
- Poly(vinyl alcohol) (PVA)	7	
- Polymethyl Methacrylate (PMMA)	3.5	Veres, et al, <i>Chem. Mat.</i> 2004, 16, 4543
- Polypropylene	1.5	Veres, et al., <i>Chem. Mat.</i> 2004, 16, 4543
- Silsesquioxane polymers		Z. Bao et al., <i>Adv. Func. Mat.</i> 2002, 12, 526
- Ferroelectric Polymers		Schroeder et al., <i>Adv. Mater.</i> 2004, 16, 633.
- Benzocyclobutene (BCB)		Unni et al., <i>Appl. Phys. Lett.</i> 2004, 85, 1823.
- Merck TCI-01		

Organic/Inorganic Composites

To be considered:

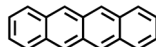
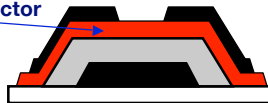
- Processing compatibility and adhesion
- Different devices must be compared with normalized gate capacitance.
- Low cost processing
- Electrical properties



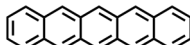
Organic Semiconductors

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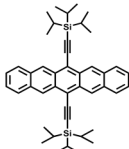
Organic semiconductor



Tetracene: $\mu = 0.1 \text{ cm}^2/\text{Vs}$; ON/OFF: 10^6 ; $V_t = -3\text{V to } -5\text{V}$
Gundlach et al *Appl. Phys. Lett.* **2002**, 80, 2925.

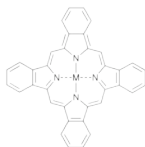


Pentacene: $\mu = 1.2 \text{ cm}^2/\text{Vs}$; ON/OFF: $>10^8$; $V_t = -5\text{V}$
Gundlach et al *IEEE Elec. Dev. Lett.* **1997** 18, 87



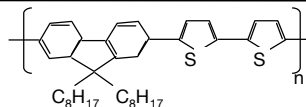
TIPS Pentacene:

$\mu = 0.4 \text{ cm}^2/\text{Vs}$; on/off: 10^6
Sheraw et al, *Adv. Mat.* **2003** 15, 2009



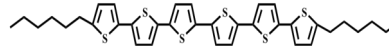
Metallotetrabenzoporphyrin:

$\mu > 0.1 \text{ cm}^2/\text{Vs}$; on/off: 10^5 ; $V_t \sim 0 \text{ V}$
Aramaki et al., *Appl. Phys. Lett.*, **2004** 84, 2085.



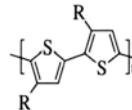
F8T2: $\mu = 4 \times 10^{-3} \text{ cm}^2/\text{Vs}$; on/off: 10^5

S. Martin, et al., *J. of SID*, **11**, 543 (2003).



Sexithiophene: $\mu = 0.05 \text{ cm}^2/\text{V-s}$

Garnier et al *J. Am. Chem. Soc.* **1993**, 115, 8716



P3HT: $\mu = 0.1 \text{ cm}^2/\text{Vs}$; on/off: 10^5

Z. Bao, et al, *Appl. Phys. Lett.* 69, 4108 (1996).

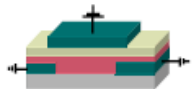
F8T2: poly(9,9-dioctylfluorene-co-bithiophene)

P3HT: poly(3-hexylthiophene)



Future Organic Semiconductors

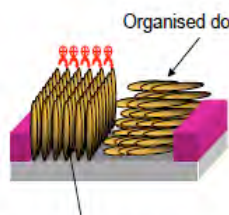
17



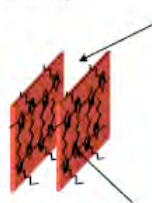
- High field-effect mobility
- Low threshold voltage and subthreshold slope
- High ON/OFF ratio and low OFF-current
- Free of charge traps and other defects
- Environmental, electrical and thermal stability
- Low cost processing

Strategies to increase charge carrier mobility

Control of Morphology



Aligned, organised domains



Planar polymer conformation

Crystalline organic semiconductors with well-defined structure, morphology, and chemical composition are desired!



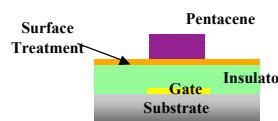
Control of Chemical Structure and Impurities



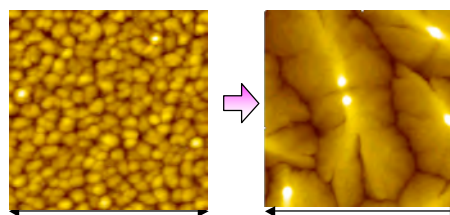
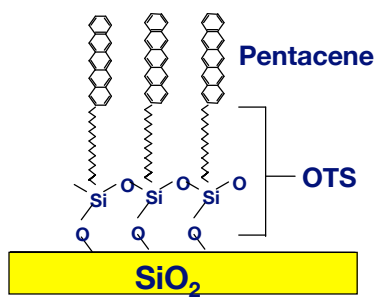
Gate Insulator Surface Treatment: SiO₂ and Organics

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- Self assembling monolayers widely used
 - Promote adhesion
 - Improve uniformity of films
 - Improve device performance, e.g, mobility.
 - Increase grain size
- Examples
 - Hexamethyldisilazane (HMDS)
 - Octadecyltrichloro-silane (OTS)
 - 7-octenyltrichlorosilane (VTS)
 - Benzyltrichlorosilane (BTS)
 - Alkanephosphonic acid
 - Cinnamic acid



Gundlach et al, *SPIE*, **2001**, 4466, 54
 Salleo et al, *Appl. Phys. Lett.*, **2002**, 81, 4383
 Salleo et al, *Appl. Phys. Lett.*, **2002**, 81, 4383
 Kelley et al, *J. Phys. Chem. B*, **2003**, 107, 5877
 Swiggers et al, *Appl. Phys. Lett.*, **2001**, 79, 1300

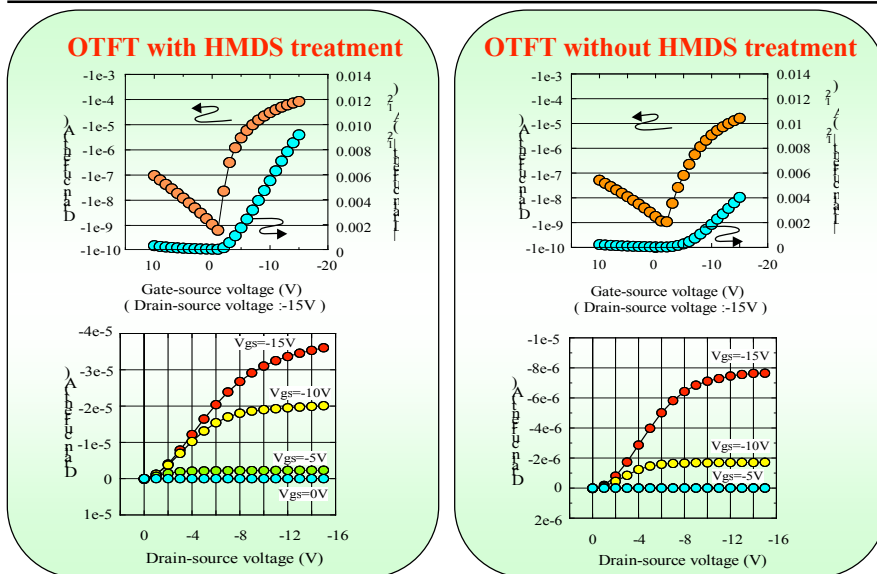


No treatment on insulator Treatment on insulator



Gate Insulator Surface Treatment: Ta₂O₅

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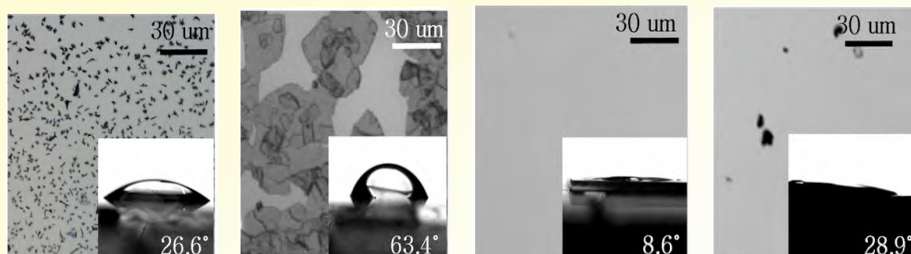
Pioneer sound.vision.soul

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Gate Insulator Surface Treatment: PVP

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Control of PVP surface allows selective growth of pentacene layer

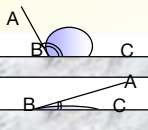


Without surface treatment

OTS treated surface

O₂ plasma treated PVP

O₂ plasma+OTS treated PVP



OTS treatment → Hydrophobic surface

O₂ plasma → Hydrophilic surface

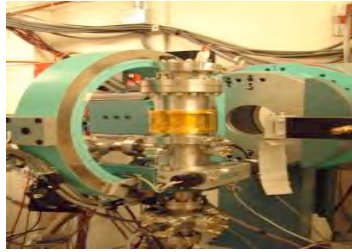
AIRC

Poly(4-vinyl phenyl) (PVP)

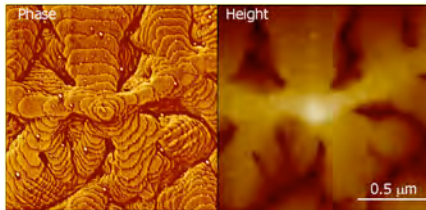
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Semiconductor Deposition Methods - Vacuum Evaporation

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- - **Vacuum evaporation from a solid**
 - Solid, usually powder, form is heated under vacuum to evaporate or sublimate, and then condenses onto a target substrate.
- **Advantages**
 - Highly crystalline films
 - Precise control on film thickness
 - Allows for In Situ study of film growth
- **Drawbacks**
 - Relatively expensive for large-area films, and requires a vacuum chamber.
 - Slow growth rate typically required to produce large crystals.



Important Issues

- Chemical stability
- Impurities
- Island definition
- High resistivity

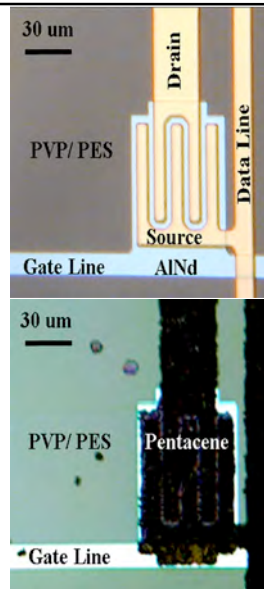
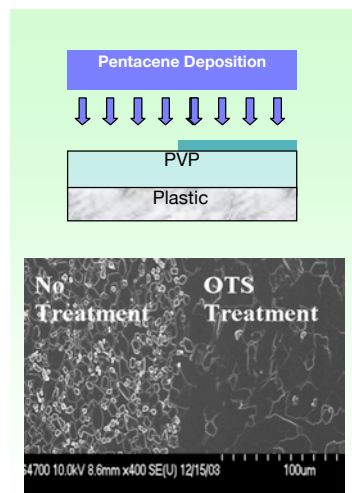


Cornell University



Semiconductor Deposition Method - Selective Growth

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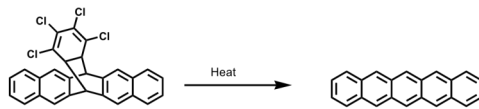


J. Jang et al., *Adv. Mat.*, 2004.

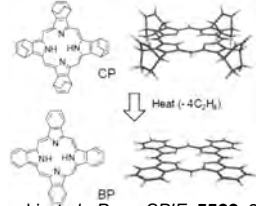


Semiconductor Deposition Methods - Precursor Solutions

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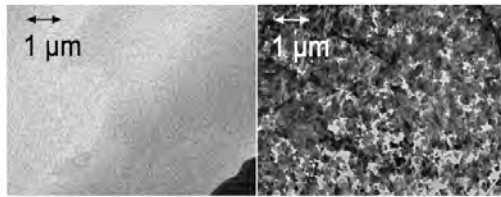


A.R. Brown et al., *Appl. Phys. Lett.*, **79**, 2136-2138.



S. Aramaki et al., *Proc. SPIE*, **5522**, 27-35.

- Functionalized precursor forms of a molecule can be used to allow solution-processing.
- Application of heat in an inert atmosphere removes unstable part of molecule, and leaves polycrystalline thin-film.
- Spin-, Dip-, and Drop-casting possible.
- Printing allows for precise control of active material.



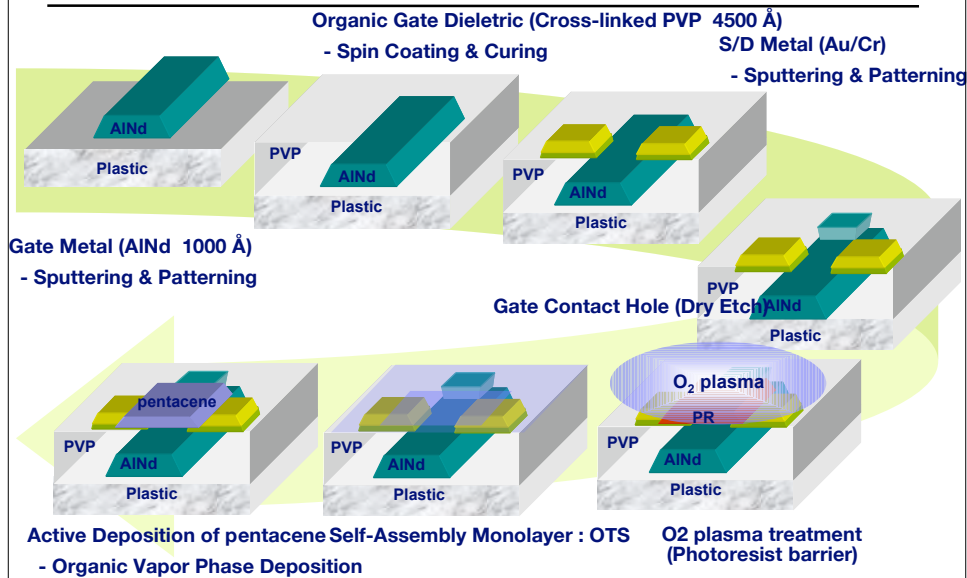
Amorphous CP

Polycrystalline TBP

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Device Fabrication: Evaporated Pentacene OFET

24

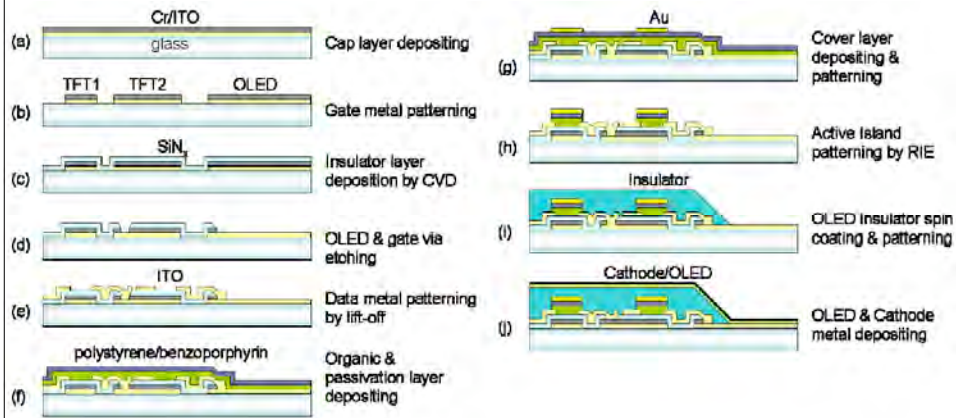


A **D** **R** **C**
Advanced Research Center

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Device Fabrication: Solution-Processable OFET-based Display

25



S. Aramaki et al., *SID 2006*, L-3, 2006.



Device Fabrication: High Resolution Patterning Methods

26

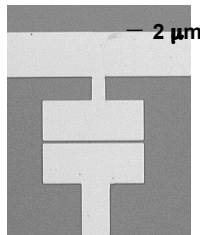
Screen printing



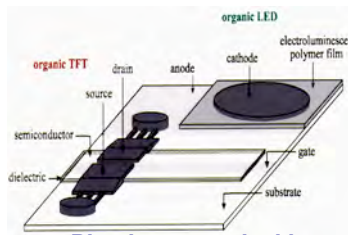
Z. Bao et al. *Chem. Mater.* **9**, 1299 (1997)
R. Service, *Science*, **278**, 383 (1997)

First all-printed plastic circuit

Soft lithography (Z. Bao et al, APL 1998, Adv. Mater. 2000, J. Mater. Chem. 1999)



Microcontact printed Au electrodes

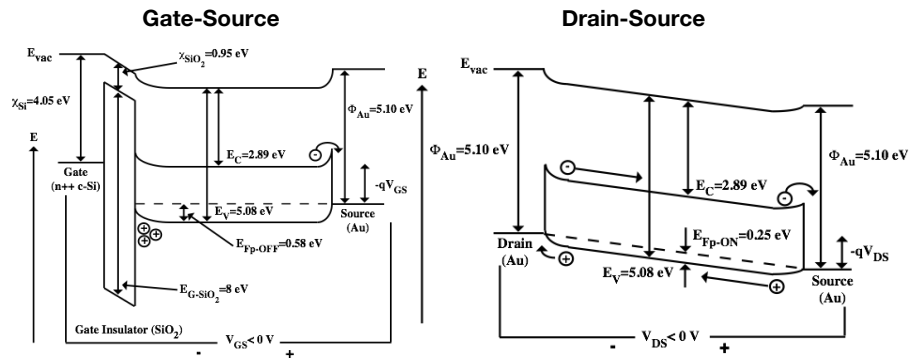


Plastic smart pixel by molding and casting



Introduction: Example OFET Bands Diagram

27



Fermi energy level determined by measuring the thermal activation energy of I_D at varying V_{GS} .

P. B. Shea, A. R. Johnson, N. Ono, and J. Kanicki, "Electrical Properties of Staggered Electrode, Solution-Processed, Polycrystalline Tetrabenzoporphyrin Field-Effect Transistors," *IEEE Trans. Electron Devices*, vol. 52, pp. 1497-1503, 2005.

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OFET Physics - Equations

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Gradual channel approximation ... MOSFET square-law theory:

Linear regime ($V_{GS} > V_T$, $V_{DS} < V_{GS}$) for low V_{DS} :

$$I_D = -\mu_{FE} C_{ins} \frac{W}{L} (V_{GS} - V_T) V_{DS} \quad \left\{ \begin{array}{l} I_D = -\mu_{0lin} C_{ins} \frac{W}{L} (V_{GS} - V_{Tlin})^\gamma V_{DS} \\ \mu_{FElin} = \mu_{0lin} (V_{GS} - V_{Tlin})^{\gamma-1} \end{array} \right.$$

Saturation regime ($V_{GS} > V_T$, $V_{DS} = V_{GS} - V_T$):

$$I_D = -\mu_{FE} C_{ins} \frac{W}{2L} (V_{GS} - V_T)^2 \quad \left\{ \begin{array}{l} I_D = -\mu_{0sat} C_{ins} \frac{W}{(\gamma+1)L} (V_{GS} - V_{Tsat})^{\gamma+1} \\ \mu_{FEsat} = \mu_{0sat} (V_{GS} - V_{Tsat})^{\gamma-1} \end{array} \right.$$

Where γ is an exponent added to account for nonlinear curves.

M. C. Hamilton *et al*, *Chem. Mater.* **16**, 4699 (2004).

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OFET Electrical Characterization Methods

29

Critical issues in FET electrical characterization:

- Ensure device reaches (quasi?) steady state (esp. at low $|V_{GS}|$)
- Limit aging (stress) during measurement (esp. at high $|V_{GS}|$)
- Limit noise (low drain currents, high gate leakage currents)
- Reproducibility

Transfer characteristics (I_D - V_{GS}):

Selected procedures:

- direction: depletion \rightarrow accumulation \rightarrow depletion
- sweep (gradually increase/decrease $|V_G|$)

OR:

- pulse sweep (increase/decrease $|V_G|$ in pulses that return to zero with low duty cycle (<50%))

Output characteristics (I_D - V_{DS}):

Selected procedure:

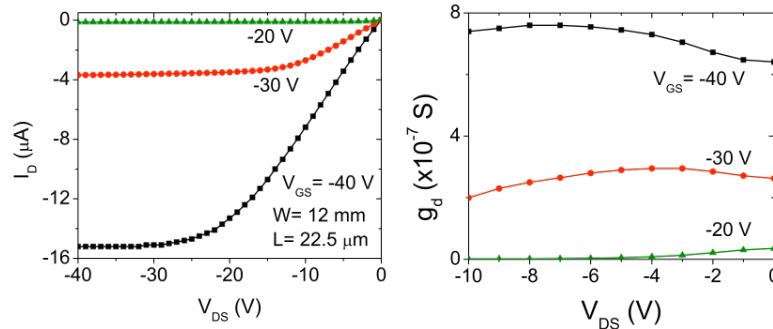
- direction: OFF (low $|V_{DS}|$) \rightarrow ON (high $|V_{DS}|$)
- sweep (gradually increase $|V_{DS}|$)

IEEE Standard 1620



Example OFET Output Characteristics

30

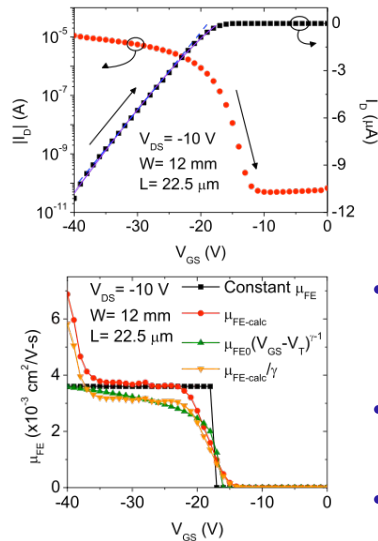


- TBP OFETs demonstrate distinct linear and saturation regimes.
- Low gate leakage current as demonstrated by no offset in I_D at low V_{DS} .
- Conductance (dI_D/dV_{DS}) indicates small amount of current crowding.

P. B. Shea et al., *IEEE Trans. Electron Devices*, vol. 52, pp. 1497-1503, 2005.



Example OFET Transfer Characteristics - Linear Regime



P. B. Shea et al., *J. Appl. Phys.*, vol. 98, 014503, 2005.

$$I_{D\text{-Linear}} = -\frac{W}{L}\mu_{FE}C_i(V_{GS}-V_T)V_{DS}$$

$$\rightarrow \mu_{FE}^{Lin} = \text{constant}$$

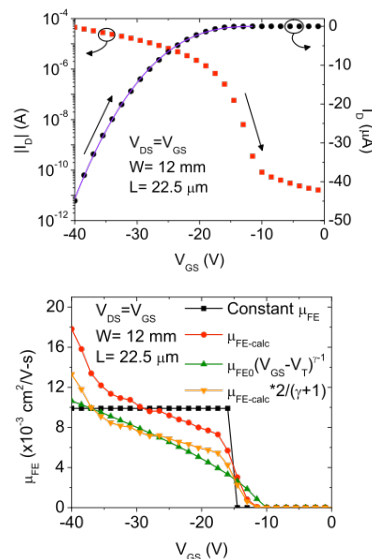
$$\rightarrow \mu_{FE\text{-calc}}^{Lin} = \frac{dI_D}{dV_{GS}} \times \frac{L}{WC_iV_{DS}}$$

$$I_{D\text{-Linear}} = -\frac{W}{L}\mu_{FE0}^{Lin}C_i(V_{GS}-V_T)^{\gamma}V_{DS}$$

$$\rightarrow \mu_{FE}^{Lin} = \mu_{FE0}^{Lin}(V_{GS}-V_T)^{\gamma-1}$$

- Dispersive charge transport induces a V_{GS} -dependent field-effect mobility; resulting nonlinear I_D - V_{GS} accounted for by introducing exponent to the current-voltage equations.
- TBP OFETs display a small nonlinearity compared to polymer OFETs:
 - $\gamma=1.2$, $\mu_{FE0}=0.002$ $\text{cm}^2/\text{V}\cdot\text{s}$, $V_T=-17.0$ V.
- $I_{ON}/I_{OFF} > 10^5$

Example TBP OFET Transfer Characteristics - Saturation



P. B. Shea et al., *J. Appl. Phys.*, vol. 98, 014503, 2005.

$$I_{D\text{-Saturation}} = \frac{W}{2L}\mu_{FE}C_i(V_{GS}-V_T)^2$$

$$\rightarrow \text{constant}$$

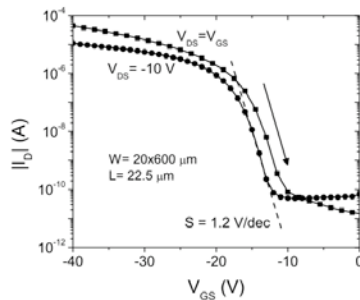
$$\rightarrow \left(\frac{d\sqrt{|I_D|}}{dV_{GS}}\right)^2 \times \frac{2L}{WC_i}$$

$$I_{D\text{-Saturation}} = -\frac{W}{(\gamma+1)L}\mu_{FE0}^{Sat}C_i(V_{GS}-V_T)^{\gamma+1}$$

$$\rightarrow \mu_{FE}^{Sat} = \mu_{FE0}^{Sat}(V_{GS}-V_T)^{\gamma-1}$$

- Dispersive charge transport induces a V_{GS} -dependent field-effect mobility; resulting nonlinear I_D - V_{GS} accounted for by introducing exponent to the current-voltage equations.
- TBP OFETs display a small nonlinearity compared to polymer OFETs:
 - $\gamma=1.7$, $\mu_{FE0}=0.0011$ $\text{cm}^2/\text{V}\cdot\text{s}$, $V_T=-10.8$ V.

Example Subthreshold Behavior and Trap Densities



$$S = \frac{kT}{q \log(e)} \left[1 + C_i (\sqrt{\epsilon_s N_{bs}} + q N_{ss}) \right]$$

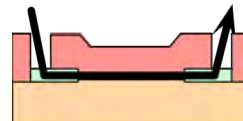
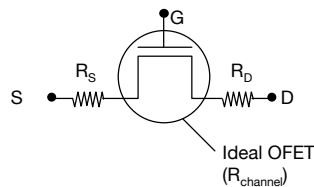
$$\sigma_t = \frac{C_i V_T^{Lin}}{q}$$

P. B. Shea et al., *J. Appl. Phys.*, vol. 98, 014503, 2005.

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- Best $S=1.2$ V/decade in the linear regime.
- V_T between -20 V and 0 V depending on sweep direction.
- Measured $\epsilon_s=3.76$ (by ellipsometry)
- $N_{ss-max}=2.9 \times 10^{12} \text{ cm}^{-2} \text{ eV}^{-1}$, $N_{bs-max}=4.10 \times 10^{18} \text{ cm}^{-3} \text{ eV}^{-1}$.
- For $V_T=-17$ V, $\sigma_t=2.6 \times 10^{12} \text{ cm}^{-2}$. For a 120-nm thick film, $N_t=2.2 \times 10^{17} \text{ cm}^{-3}$.
- Assuming mid-gap trap states, $N_{ss-max} \times E_T/2 \approx \sigma_t$.
- Trap densities moderate compared to other organic semiconductors, and constant with energy.

OFET Source Drain Contact Issues



- Measured (apparent) device field-effect mobility $\mu_{FE \text{ app}}$:
 - Conduction channel (intrinsic) field-effect mobility $\mu_{FE \text{ int}}$
 - Source / drain series resistances (contacts)
- Conduction channel resistance ($R_{channel}$) \propto channel length (L)
- S/D series resistances channel length independent

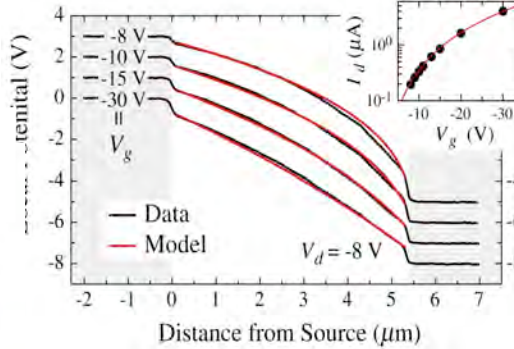
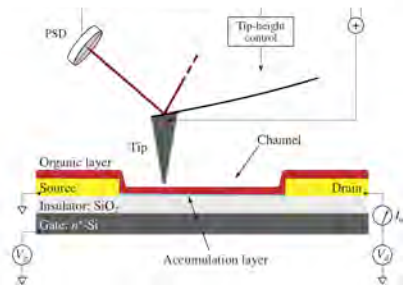
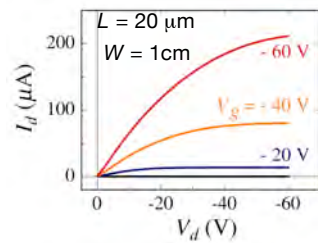


- Series of OFETs with same characteristics but different L (Transverse Line Method) is measured.

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OFET Source Drain Contact - Potentiometry

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Potential profiles in good agreement with those predicted by standard inorganic MOS theory.

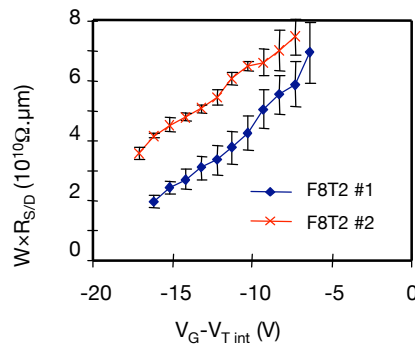
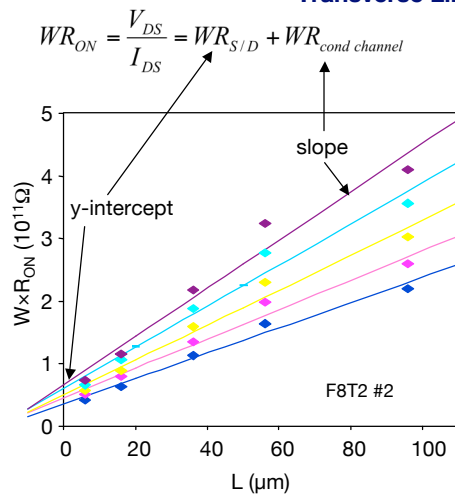
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OFET Source Drain Contacts

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Transverse Line Method (TLM)



$R_{S/D} \sim 10^9 \Omega$ for $|V_{GT}| \sim 10V$
 $(a\text{-Si:H } R_{S/D} \sim 10^6 \Omega \text{ for } |V_{GT}| \sim 10V)$

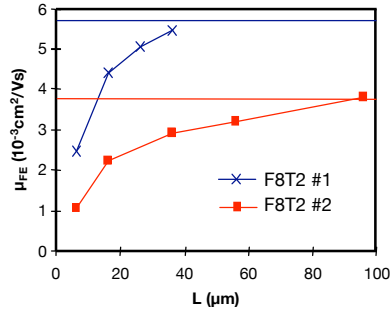
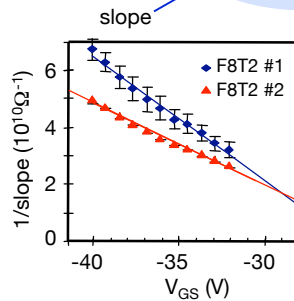
S. Martin et al, *Mat. Res. Soc. Sym. Proc.* **771**, 163, (2003).

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OFET Intrinsic Properties

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$$WR_{ON} = \frac{V_{DS}}{I_{DS}} = WR_{S/D} + \frac{1}{\mu_{FE\text{int}} C_{ins} (V_G - V_{T\text{int}})} \times L$$



	$\mu_{FE\text{int}}$ (cm^2/Vs)	$V_{T\text{int}}$ (V)
F8T2 #1	5.6×10^{-3}	-24
F8T2 #2	3.8×10^{-3}	-23

- For many polymers, the OFET performance is limited by the channel conductivity, NOT the series resistances: no channel length dependence of μ_{FE} .
- Effect of R_{SD} is expected to become noticeable for high-performance OFETs, i.e. devices with high μ_{FE} or short L.

Effect of Gate Insulator Dielectrics

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Organic Semiconductor-Insulator interface

- Key interface for performance (μ_{FE} , V_{T1} , etc.) and stability (hysteresis)
- Improve semiconductor morphology at interface
- Reduce dipole disorder at interface
- Methods:
 - Chemical treatment (SAMs of HMDS, OTS, etc.)
 - Mechanical treatment (rubbing, patterning)
 - Low-k (organic) insulators (PI, PMMA, PVP, PVA, etc.)

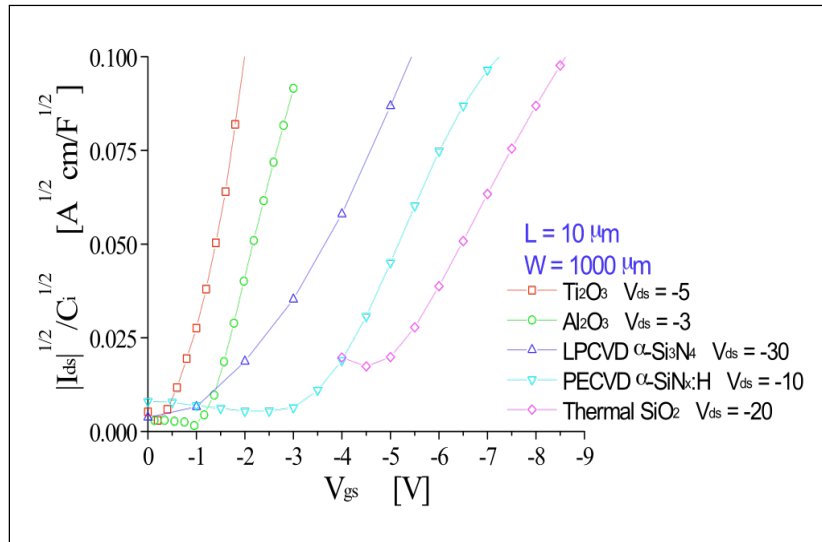


L. Kinder, et al, *Proc. SPIE* 5217, 35 (2003).

J. Veres, et al, *Chem. Mater.* 16, 4543 (2004).

Effect of Gate Insulator on F8T2 OFET Performance

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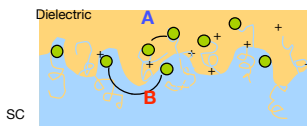
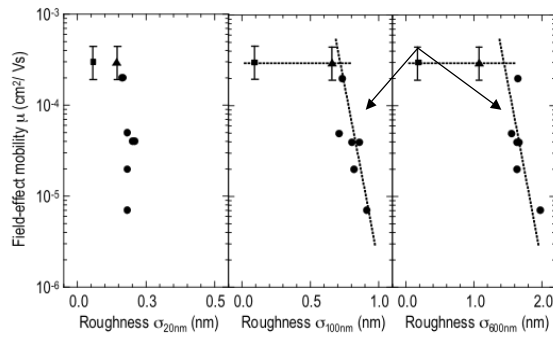


J. Swensen et al., *Proc. SPIE*, 5217, 159-166 (2003).



Influence of Interface Roughness

40



- Clear correlation between mobility and roughness on a 100nm length scale (\gg hopping length scale)
- Possible explanation: Lateral variations in charge density when roughness comparable to thickness of accumulation layer

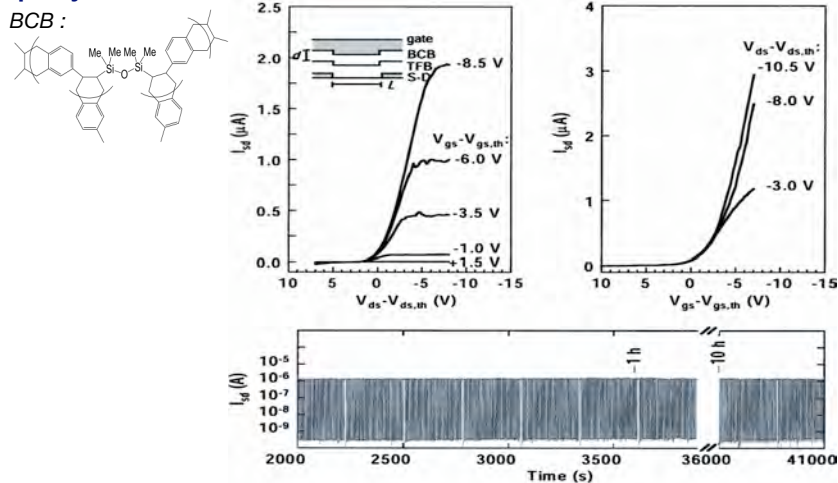


Ultrathin Organic Gate Insulator Dielectric

41

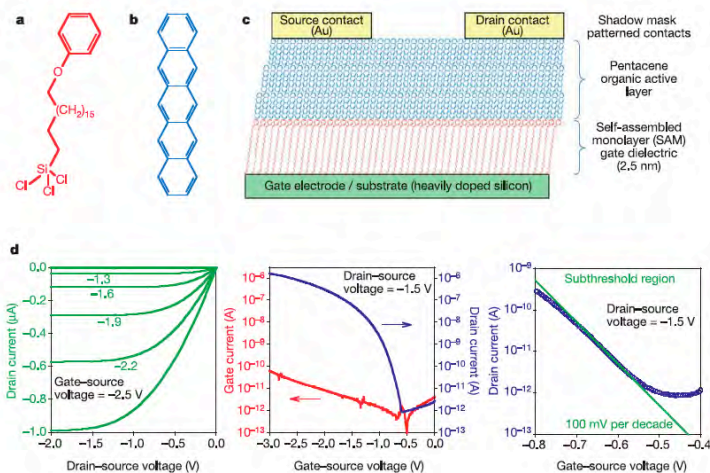
Leakage current $< 10^{-6}$ A/cm² at field of 3MV/cm

Good bias stress stability at elevated temperatures (120°C) – High purity / thermal stability of BCB interface



Example Electrical Performance of Pentacene

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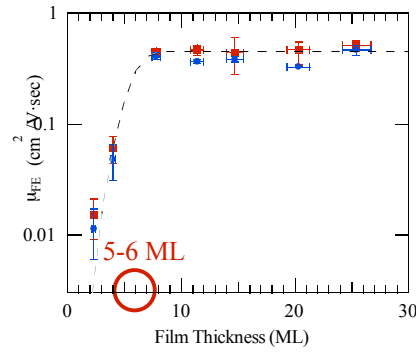
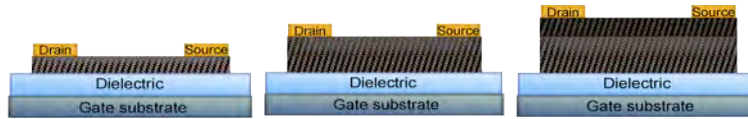
W/L= 170/130
 $\mu = 1$ cm²/V-s
 $V_T = -1.3$ V
 ON/OFF = 10⁶

M. Halik et al., *Nature*, **431**, 963-966 (2004).



Thickness Dependence of Field-Effect Mobility

43



$$\mu_{FE} = \mu_{sat} \left(1 - \text{Exp} \left[- \left(\frac{\theta}{\theta_0} \right)^\alpha \right] \right)$$

Also in sexithiophene: F. Dinelli et al., Phys. Rev. Lett. 92, 116802 (2004).
Theory: G. Horowitz, J. Mat. Res. July 2004

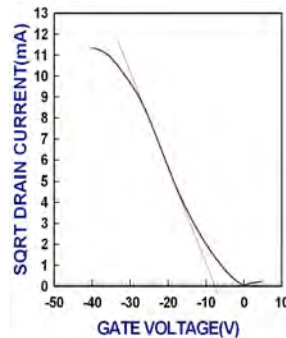
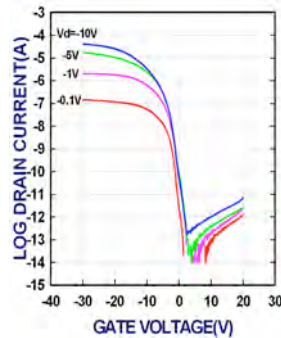


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Example Electrical Performance of Selectively Grown Pentacene

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$W / L = 200 \mu\text{m} / 6 \mu\text{m}$

$\mu_{FE} = 1.8 \text{ cm}^2/\text{Vs}$

$V_{th} = -7.5 \text{ V}$

$S = 0.9 \text{ V/dec}$

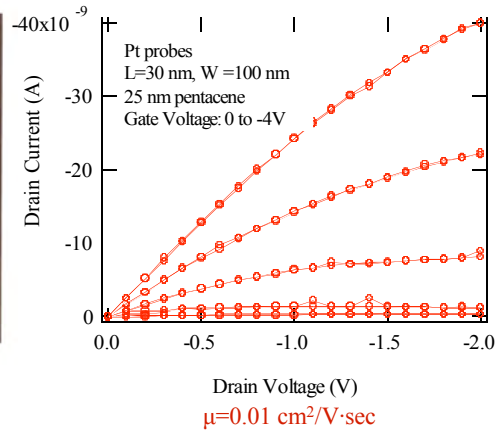
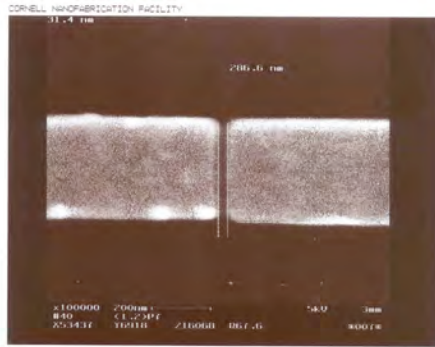
$I_{on} / I_{off} > 10^8$



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Nanoscale Pentacene OFETs

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CNF Cornell Nanofabrication Facility



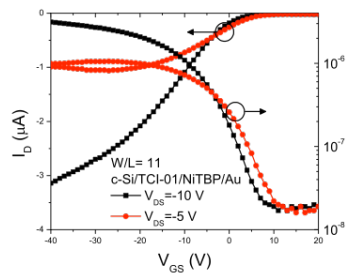
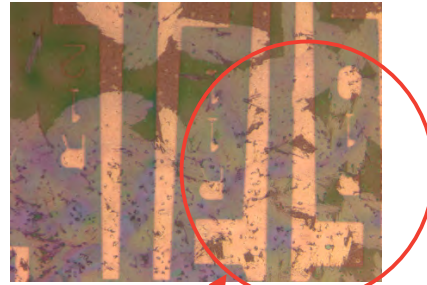
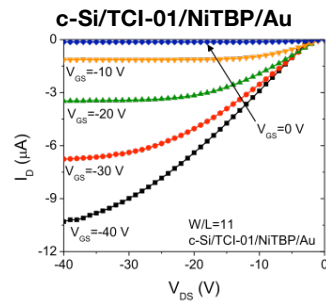
Cornell University

Only low field-effect mobility was achieved.
Y. Zhang et al., *Adv. Mater.* 15, 1632 (2003).

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Example NiTBP OFET on TCI-01

46

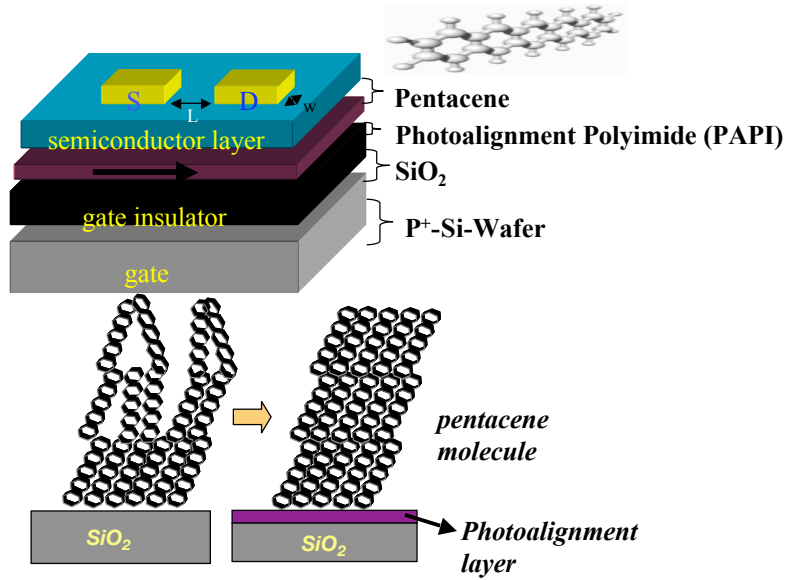


Threshold voltages around 0 V.
 $I_{OFF} \sim 10$ nA.
Large NiTBP crystals form in TCI-01 and PVP.
 $T_{max} = 165$ °C.
 $\mu_{FE} = 0.6$ cm²/V-s, $V_1 = 0$ V, $S = 7$ V/dec,
 $I_{ON}/I_{OFF} = 10^2$.

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Alignment of Pentacene Molecules Within Channel

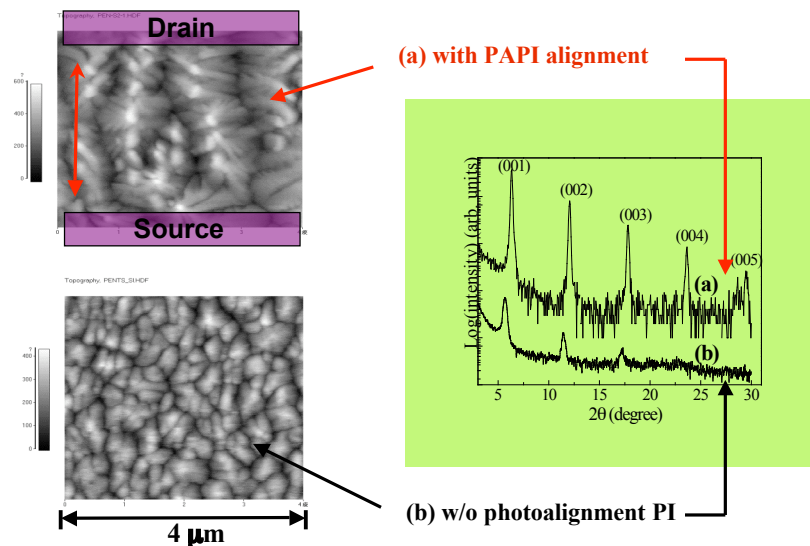
47



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Alignment of Pentacene Molecules Within Channel

48

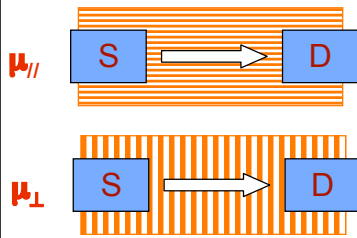


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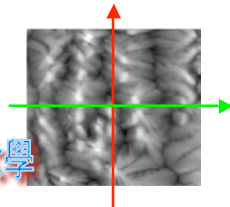
Alignment of Pentacene Molecules Within Channel

49

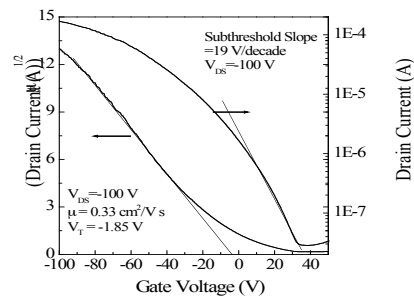
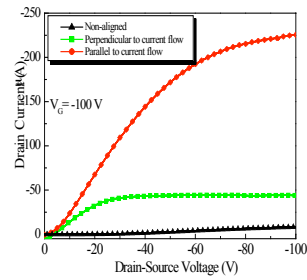


- Anisotropic field effect mobility
 $\mu_{\parallel} / \mu_{\perp} \sim 2.7 - 8.3$: dichroic effect

(Carriers transport parallel and perpendicular to the alignment direction)



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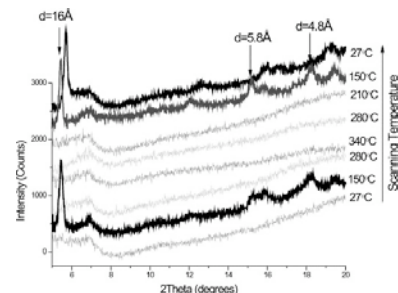
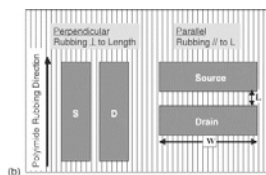
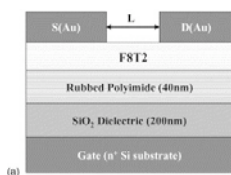


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Structural Alignment of F8T2 Films

50

- Polyimide gate dielectric rubbed preceding F8T2 spin-casting.
- F8T2 films heated above melting temperature, then cooled.
- XRD shows polymer chains align preferentially in direction of rubbing.



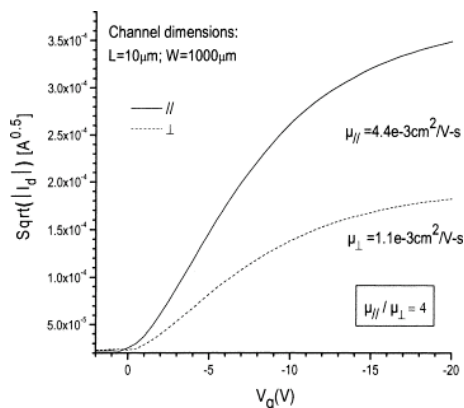
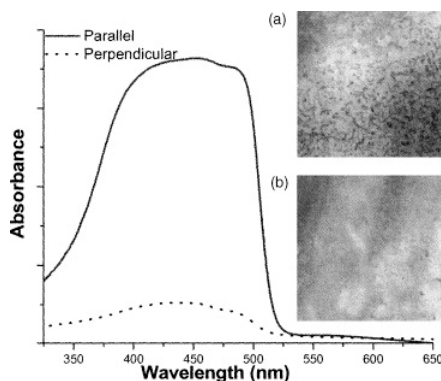
L. Kinder *et al.*, *Synth. Met.*, vol. 146, pp. 181-185, 2004.

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Structural Alignment of F8T2 Films

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- Optical absorption measurements indicate polarization anisotropy.
- OFET measurements also indicate field-effect mobility anisotropy.



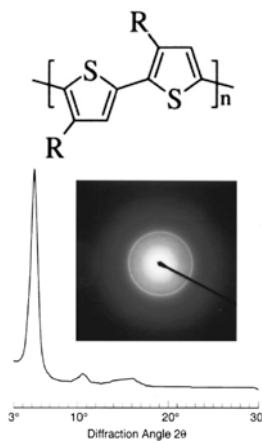
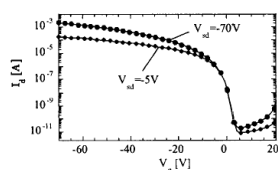
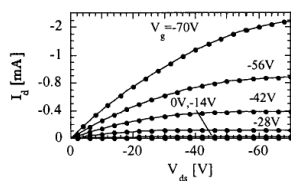
L. Kinder et al., *Synth. Met.*, vol. 146, pp. 181-185, 2004.

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Example Electrical Performance of Polymers

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P3HT (poly-3-hexylthiophene)/SiO₂



$\mu = 0.1 \text{ cm}^2/\text{V-s}$
 $V_T = \sim -5 \text{ V}$
ON/OFF > 10⁶

Z. Bao, et al, *Appl. Phys. Lett.* 69, 4108 (1996).

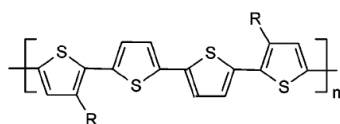
H. Sirringhaus, et al, *Synth. Met.* 102, 857 (1999).

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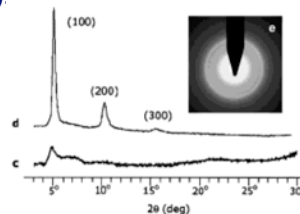
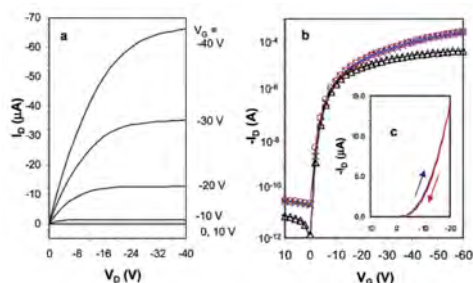
Example Electrical Performance of Polymers

53

PQT-12 (poly-3,3-dialkyl-quaterthiophene)



Crystalline - liquid crystalline and liquid crystalline - isotropic phase changes have been observed ($\sim 120^\circ$ and 140°C respectively).



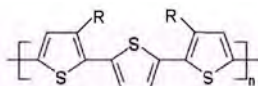
$\mu = 0.1 \text{ cm}^2/\text{Vs}$
 $V_T = -5 \text{ V}$
 $\text{ON/OFF} = 10^6$

B. S. Ong, et al, *J. Am. Chem. Soc.* **126**, 3378 (2004).

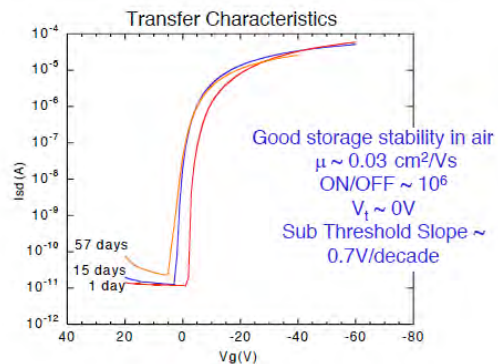
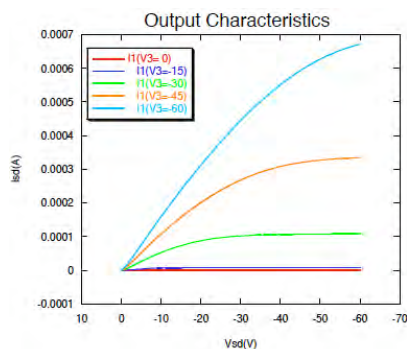
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Example Liquid Crystal Polymers

54



Thienothiophene Terthiophene

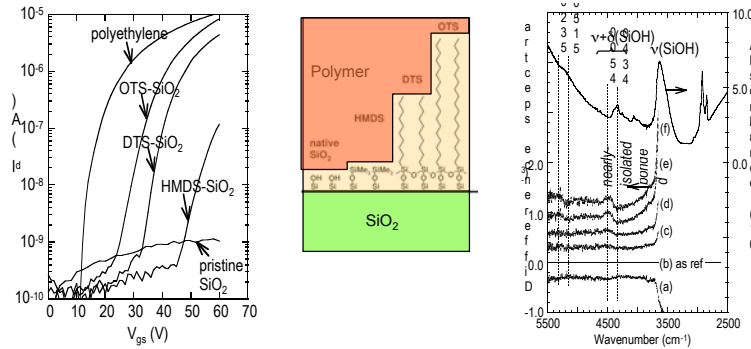


MERCK

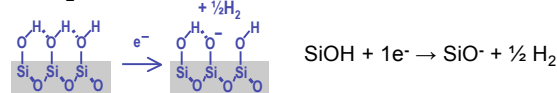
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Why has electron transport been so elusive previously ?

55



Charge trapping by electron accepting surface groups, such as silanol groups in the case of commonly used SiO₂ gate dielectric :

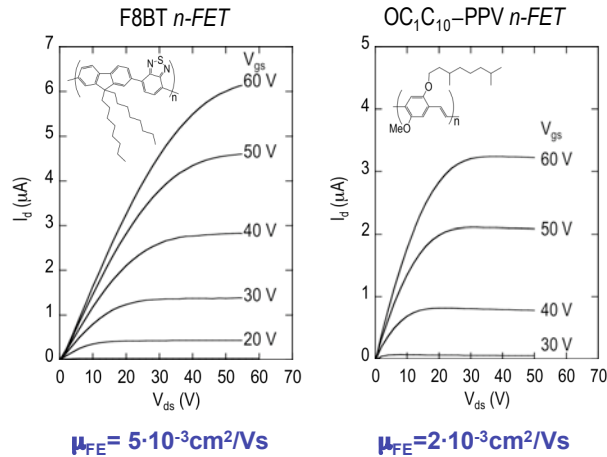


Interfaces are key, but our understanding of their electronic properties is still rudimentary!

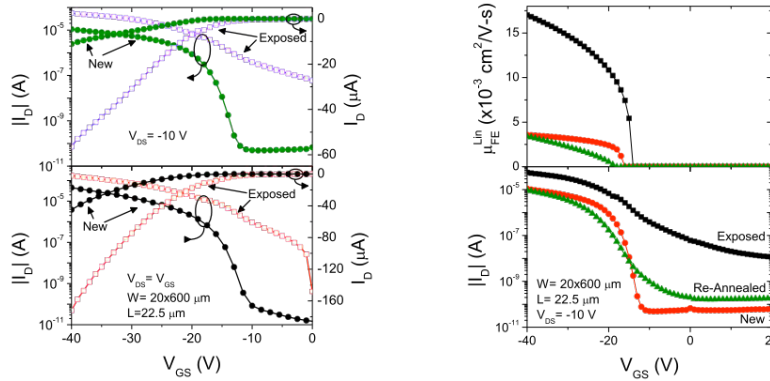


Example n-Type Polymers

56

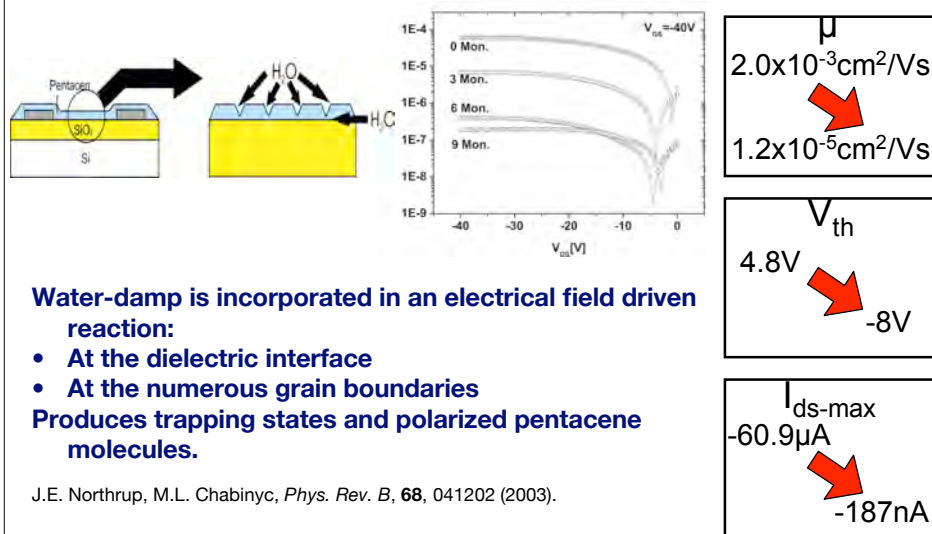


Example TBP OFET Storage Stability



- Storage in ambient atmosphere leads to significant changes:
 - Increase in overall conductivity
 - Lower ON/OFF ratio
 - Larger subthreshold swing
- Thermal annealing in N₂ or vacuum regains most of original performance.

Example Pentacene OFET Environmental Stability



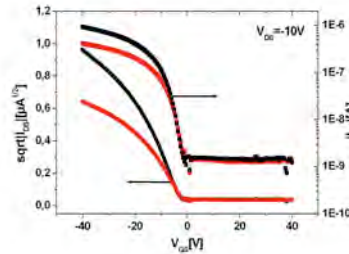
Water-damp is incorporated in an electrical field driven reaction:

- At the dielectric interface
 - At the numerous grain boundaries
- Produces trapping states and polarized pentacene molecules.**

J.E. Northrup, M.L. Chabiny, *Phys. Rev. B*, **68**, 041202 (2003).

Example Pentacene OFET Environmental Stability

59



on/off ratio
~1000

~500

V_{th}
-0.7V → 2.2V

I_{ds-max}
-9.3 μA → -4.1 μA

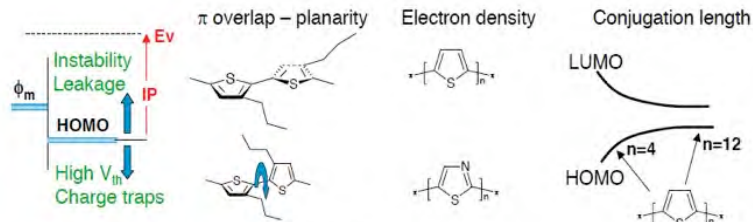
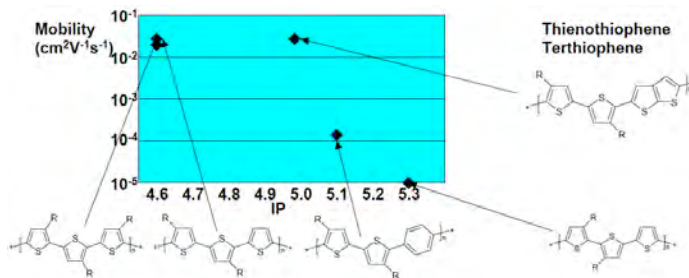
Oxygen is incorporated to produce:

- Acceptor-states for electrons
- Scattering centers for charge carriers
- Disturbance of the conjugation of the double-bonds.

O.D. Jurchescu et al, *Appl. Phys. Lett.*, **84**, pp. 3061-3063 (2004).

Reduction/Oxidation Stability in Organic Molecules

60

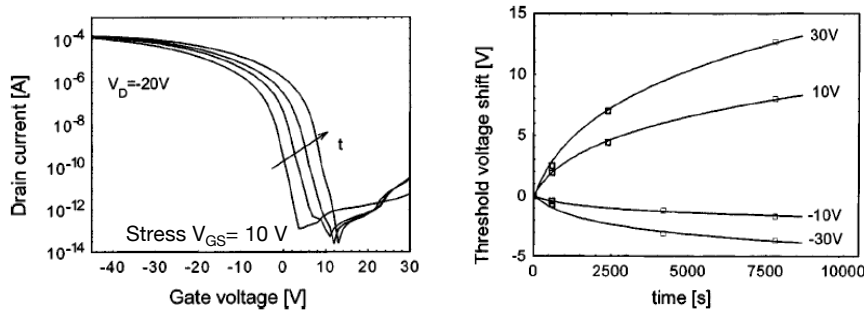


D.M. deLeeuw, et. al, *Synth. Metals.*, **87**, 53-59, (1997)

Example Pentacene OFET Electrical Stability

61

- Continuous operation (stressing) of small-molecule devices produces noticeable changes in device performance.
- Stressing pentacene devices with a gate bias for 0, 10, 30, and 90 minutes reveals significant shift in OFET threshold voltage.



D. Knipp *et al.*, *J. Appl. Phys.*, **93**, 347-355.

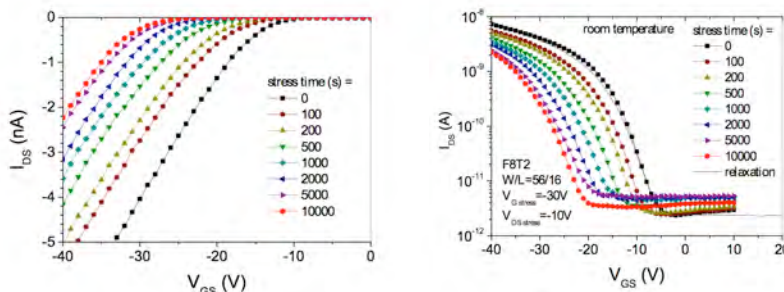


Example F8T2 OFET Electrical Stability

62

Electrical Stability (Instability)

- Significant threshold voltage shift observed after bias stress (both positive and negative).
 - Charge carrier trapping in states near organic semiconductor-gate insulator interface.
- Must be accounted for in display driving circuitry
 - Design circuits with inherent robustness against threshold voltage shifts.
 - Active-matrix pixel driving schemes set-up to allow recovery of device during down time (when not being addressed).

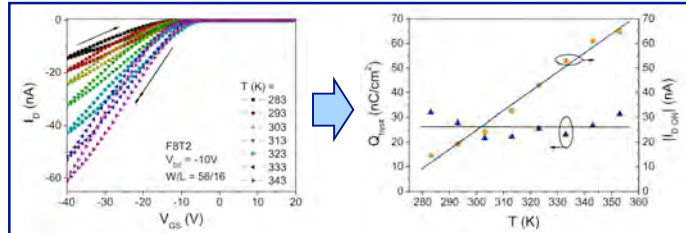


S. Martin *et al.*, *Proc. of SPIE* **5217**, 7 (2003).

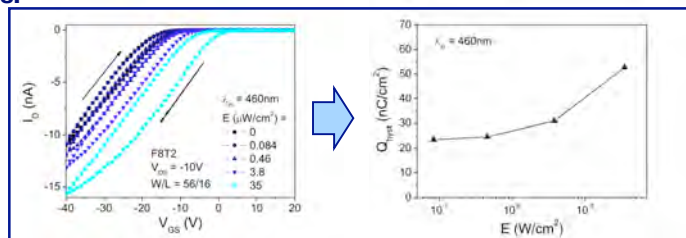


F8T2 OFET Hysteresis

Effect of temperature \Rightarrow increase of carrier mobility ($I_{D,ON}$), but not hysteresis.



Effect of monochromatic illumination \Rightarrow increases carrier density & hysteresis.

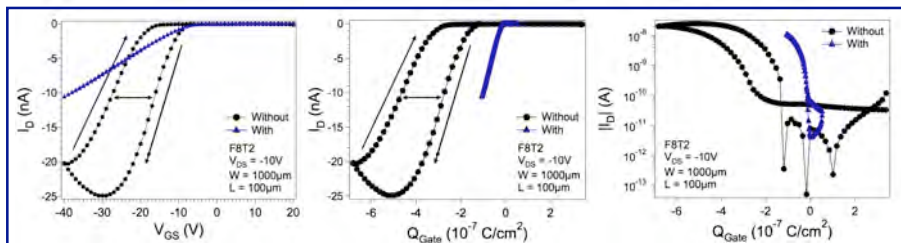


F8T2 OFET Hysteresis

Reduction of hysteresis can be achieved by using an organic insulator.

Device structures used here (fabricated at the same time, same F8T2):

- Unpatterned, heavily-doped Si wafer as gate electrode.
- SiO₂ (without) and SiO₂ + thermally cross-linkable organic insulator (with).
- F8T2 (spin-deposited from solution and cured as usual).
- Au (evaporated through shadow mask).



“Significant” gate-leakage current for both, but effect of organic insulator is obvious.

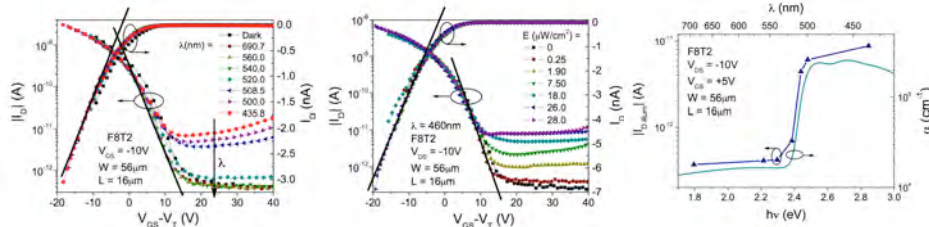
- When normalized for charge (i.e. with capacitance), mobility is same but threshold charge is much smaller, subthreshold slope is much sharper and hysteresis is removed completely.
- Evidence for improved interface (i.e. reduced interface states).

Effects of Illumination: Monochromatic

65

Monochromatic illumination at different wavelengths

- constant optical flux $\sim 1.3 \times 10^{14}$ photons/cm²s.
- different irradiances at $\lambda = 460$ nm.



Minimal response to sub-optical gap illumination ($\lambda > 520$ nm).

Maximum response to strongly absorbed illumination (peak at ~ 460 nm).

Major effect (again) decrease of V_T , no significant changes in μ_{FE} or S .

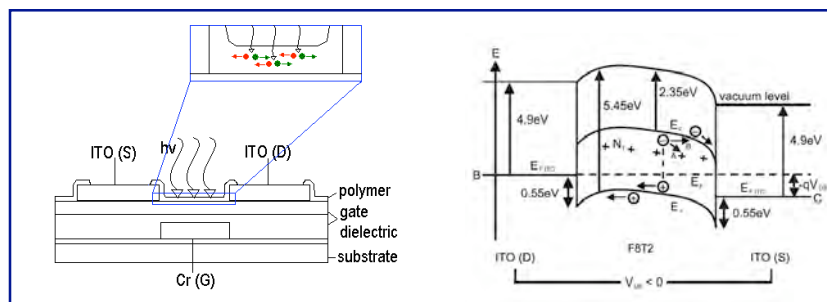
Can we describe how I_D depends on irradiance?

* M. C. Hamilton, S. Martin, and J. Kanicki, "Organic Polymer Thin-film Transistor Photosensors," *IEEE Journal of Selected Topics in Quantum Electronics*, vol. 10, pp. 840-848, 2004.



Effects of Illumination: Physical Mechanisms

66



Photoconductive device \Rightarrow photo-carrier generation due to absorption of photons in polymer channel of device.

Proposed physical mechanism:

photon absorption ... exciton formation ... diffusion ... dissociation into free carriers ... trapping of e's ... transport and collection of h's

Explains: V_T reduction, I_D increase, no change in μ_{FE} or S with illumination

Next step \Rightarrow monochromatic illumination to get more detailed results.

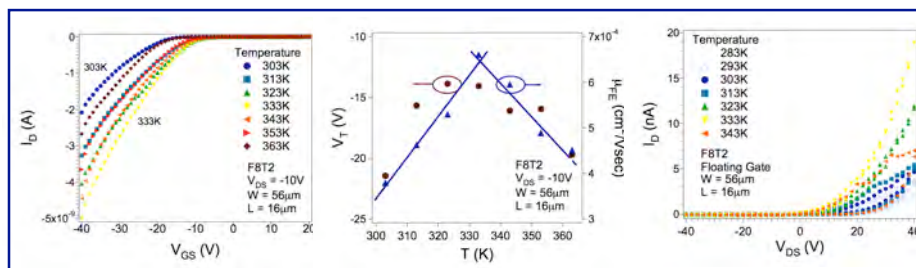


OFET Operating Temperature Range?

67

Evidence that there may be a (relatively low) operating temperature at which the device performance is optimal.

Possible relation to change in morphology and/or conformation of polymer chains with temperature (i.e. as temperature is increased, distance between chains increases, resulting in a decrease in inter-chain carrier mobility).



No apparent gate-bias dependence and no evidence from XRD or DSC.

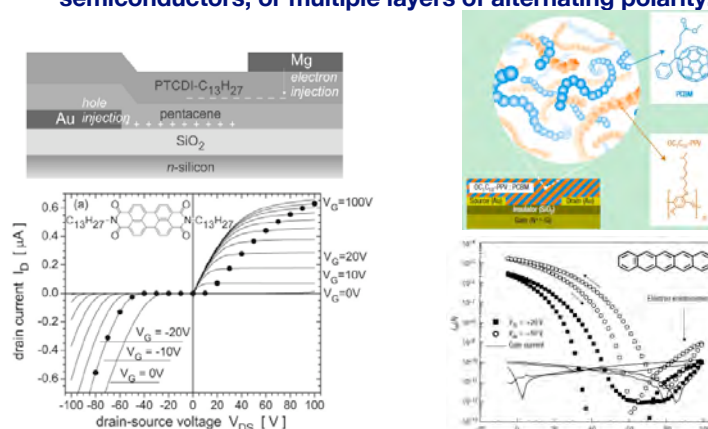
Observations are consistent with (unexplained) experimental results published by other groups...reduction of mobility at elevated temperatures (near 340K).

Implications for applications based on organic devices.

Ambipolar Organic Transistors

68

Ambipolar OFETs have been prepared using blends of organic semiconductors, or multiple layers of alternating polarity.

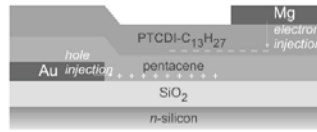
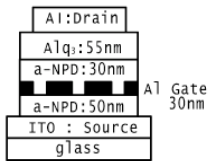


C. Rost et al., *J. Appl. Phys.*, **95**, 5782-5787 (2004).

E. Meijer et al., *Nature Mat.*, **2**, 678-682 (2003).

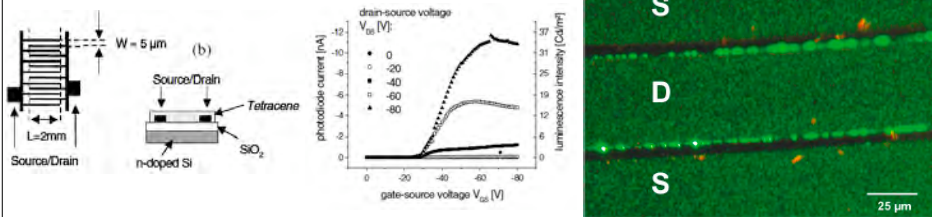
Light-Emitting Organic Transistors

69



C. Rost et al., *Syn. Met.*, **146**, 237-241.

K. Kudo et al., *Thin Solid Films*, **438-439**, 330-333.



A. Hepp et al., *Phys. Rev. Lett.*, **91**, 157406.

- Devices exhibit drain and gate-bias-dependent behavior.
- Gated OLEDs?



Possible OFET Applications

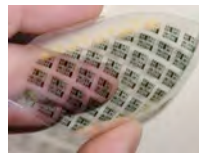
70



OFET Driven AM-EPD (Phillips)



OFET Paper Substrate (Infineon)



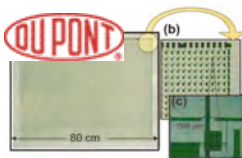
RFID (3M)



OFET Driven OLED (Pioneer)



OFET AM-LCD (Penn State Univ.)



OFET Backplane (DuPont)



OFET Backplane (Lucent/e-ink)



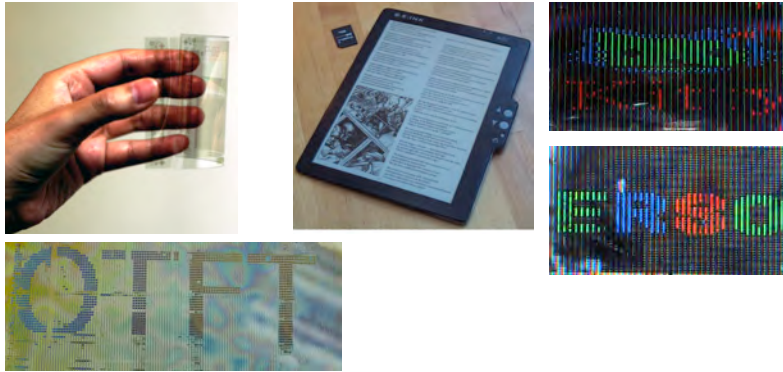
OFET Backplane (PlasticLogic)



Example of OFET-based Active-Matrix Displays

71

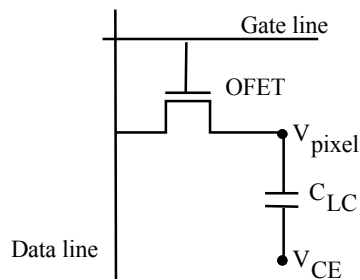
- 2000 Lucent/E-Ink 16×16 E-Paper display
- 2001 Sarnoff/Penn State/Kent State 16×16 TFT LCD
- 2002 Philips 64×64 TFT LCD
- 2003 Plastic Logic 80×60 TFT LCD
- 2003 PARC 128×128 ink-jetted TFT LCD
- 2006 Samsung SDI 4" 120×192 OTFT based AMOLED
- 2006 Plastic Logic/E-Ink 800×600 SVGA ink-jetted OTFT E-paper display



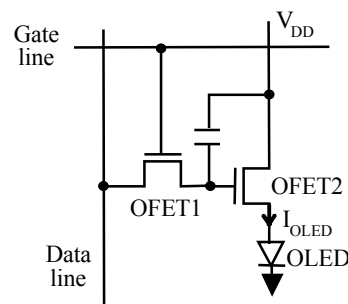
Examples of OFET Active-Matrix Addressing

72

AM-LCD typical pixel electrode driving circuit
- One TFT



AM-OLED typical pixel electrode driving circuit
- 2 TFTs minimum



- More complex pixel electrode circuits are required to accommodate for OFETs electrical stability.



Requirements for Active-Matrix Addressing

73

	AM-LCD	AM-PDLC	AM-OLED
I_{OFF} (A)	$< 2 \times 10^{-13}$	$< 2 \times 10^{-13}$	$< 10^{-12}$
I_{ON} (A)	$> 2 \times 10^{-7}$	$> 2 \times 10^{-7}$	$> 10^{-6}$
I_{ON}/I_{OFF}	$> 10^6$	$> 10^6$	$> 10^6$
V_T (V)	< 2	< 5 V	< 2 V
S (V/dec)	< 0.5	< 1.5	< 1.0
τ (switching)		> 3 ms	> 200 ns

F. Libsch, *TFTs in Active-Matrix Liquid Crystal Displays*.

S. Martin *et al.*, *J. SID*, **11/3**, 2003.

M.L. Chabinye and A. Salleo, *Chem. Mater.*, **2004**.



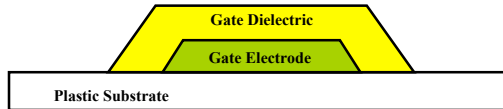
Example of OFET Active-Matrix Process (1)

74

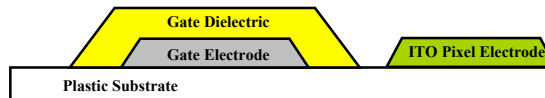
Deposit and pattern gate



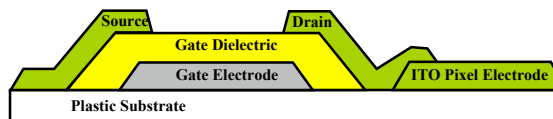
Deposit and pattern gate dielectric



Deposit and pattern ITO pixel electrode



Deposit and pattern source/drain contacts

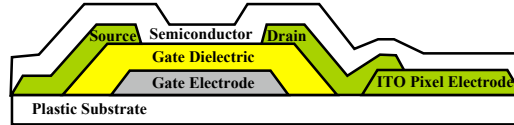


Example of OFET Active-Matrix Process (2)

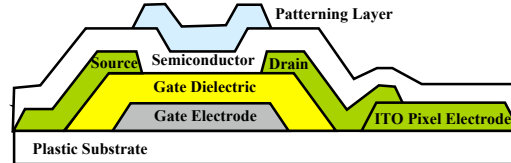
75

- Minimize leakage current between transistors.
- Deposit patterning layer. e.g.: Parylene polyvinyl alcohol (PVA), Si_3N_4

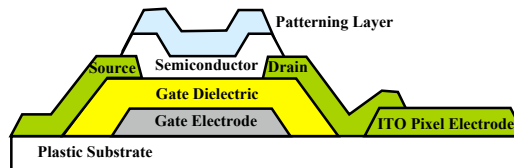
Deposit semiconductor



Define patterning layer



Etch semiconductor

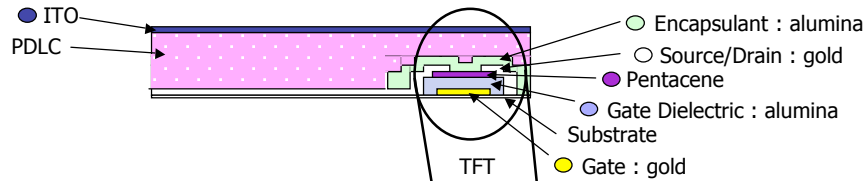


Encapsulation or passivation layers are needed.



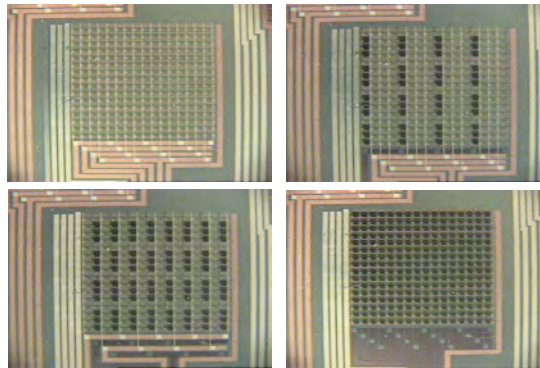
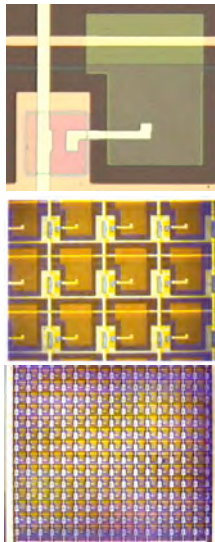
Example of Reflective AM-PDLC Backplane

76



Example of Reflective AM-PDLC on Plastic

77



Sarnoff-Penn State-Kent State Rensselaer OFET AMLCD

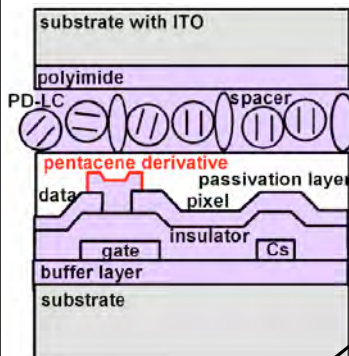
Reflective 16x16 Pixel Array
 Driven with 1/4 VGA Video
 Display Waveforms (60 Hz refresh rate, 69 μ sec line time)

M. Kane *et al.*, SID 2001.

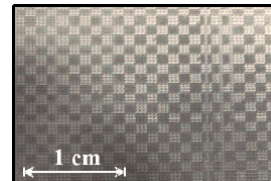
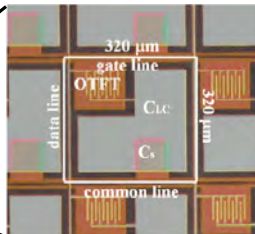


Example of Reflective AM-PDLC Display

78



- display size: 2.5 inch
- resolution: 79 dpi, QQVGA
- aperture ratio: 73 %
- frame rate: 60 Hz
- display mode: normally white
- electrode & wire: organo-Ag
- insulator: PVP-OTS
- semiconductor: pentacene
- substrate: glass

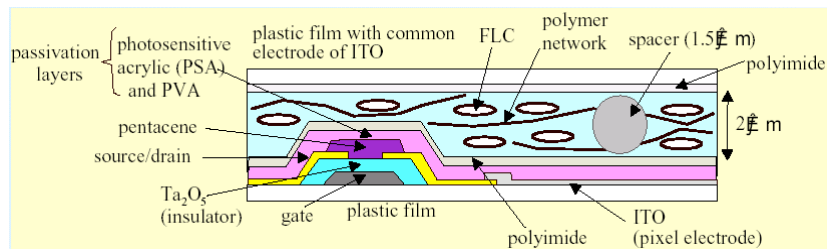


Monochromatic image of AM-PDLC

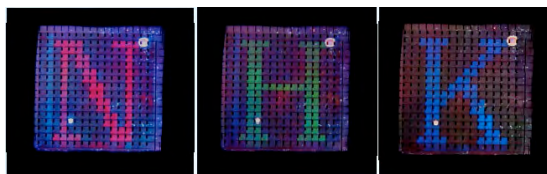
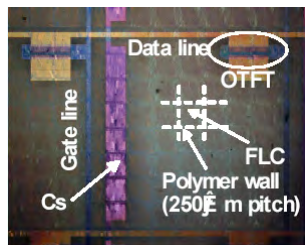


Example of AM-FLC Display

79



Film LCD : Ferroelectric LC (FLC) stabilized by polymer walls and networks



Data scan frequency : 360Hz×16

Gate voletage : 14Vpp

Data voltage : 13Vpp

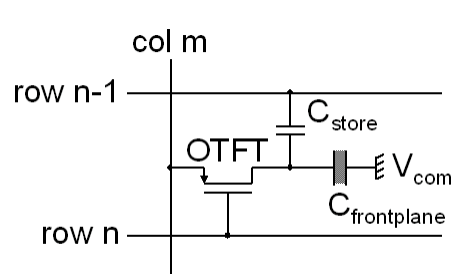
Y. Fujisaki et al., SID 2006, pp. 119-122, 2006.

N M K 放送技術研究所
Science & Technical Research Laboratories

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OFET Active-Matrix Addressing of E Ink Display

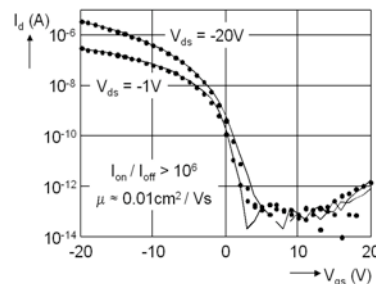
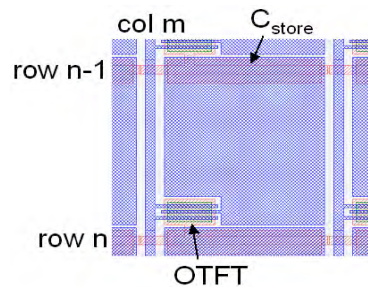
80



- ✓ Pentacene OTFTs with Au S/D contacts are used.
- ✓ $L/W = 5/140$
- ✓ Pixel size: $300 \mu\text{m} \times 300 \mu\text{m}$

For all rows:

1. Select row n: $V_{\text{row } n} = 25\text{V} \rightarrow V_{\text{row } n} = -25\text{V}$
2. Apply V_{data} (-15V ... 15V) to columns
3. Deselect row n: $V_{\text{row } n} = -25\text{V} \rightarrow V_{\text{row } n} = 25\text{V}$



PHILIPS

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Roll-up OFETs Active-Matrix E Ink Display

81

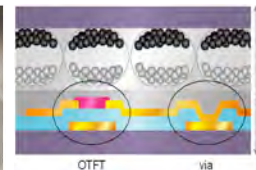
Main properties:

- 4.7" diagonal, 7.5mm roll radius
- 240 rows x 320 columns / 300 μm square pixel (85 dpi)
- 50 Hz refresh rate, 4 gray levels
- Contrast > 10
- Display type: electrophoretic (E Ink)
- Working organic shift resistors
 - : Up to 233 stages & 11 kHz



Key benefits of roll-up e-paper:

- Very flexible: rollable
- Unbreakable
- Light weight & Low power
- Integrated drivers – standard driver connection technologies cannot be used easily.

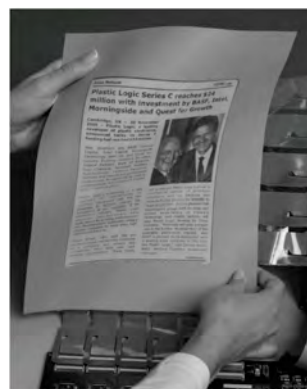
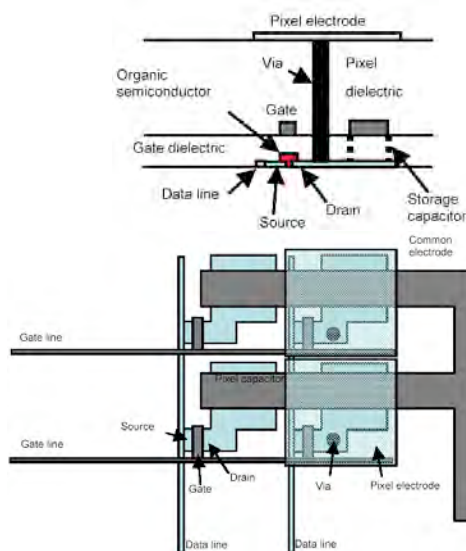


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Example of OFET Active-Matrix Flexible E Ink Display

82



- Resolution: SVGA (800x600) 100ppi
- Display size: 10"
- Backplane: PET substrate (Dupont)
- Pixel electrode: PEDOT/PSS

S. E. Burns et al., SID 2006, pp. 74-76, 2006.

E·INK Plastic Logic

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Example of Flexible OFET Active Matrix Processing

83

(a) Fix the plastic on the carrier



(b) ITO deposition and patterning as a gate electrode



(c) Coating organic insulator



(d) Source and drain electrodes patterning (ITO)

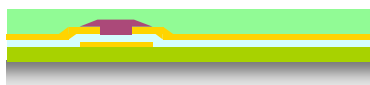


(e) Pentacene thermal deposition as an active layer

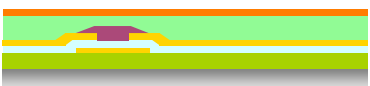


Example of Flexible OFET Active Matrix TN LCD Processing

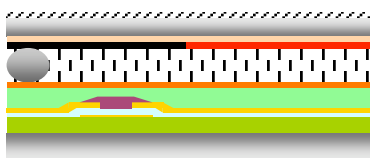
84



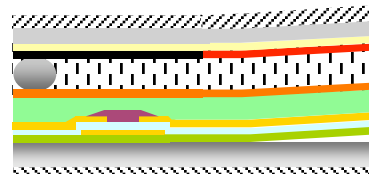
(a) Polymer passivation layer coating



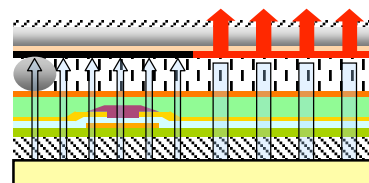
(b) PI layer coating for TNLC alignment



(c) TNLC injection and sealing



(d) Release plastic from carrier



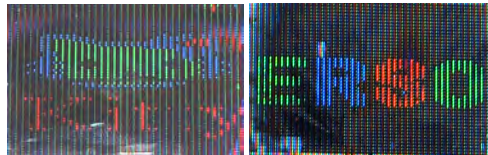
(e) The panel assembled with the back light



Example of Flexible OFET AM-TN LCDs

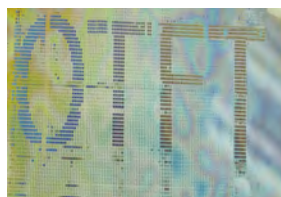
85

Color OTFT-LCD on Glass



Display: 3" OTFT-TNLC
 Resolution: 64 x 43 x 3 pixels
 Pitch: 500 μm x 1500 μm
 Device: 1T1C PMOS

Monochrome OTFT-LCD on Plastic



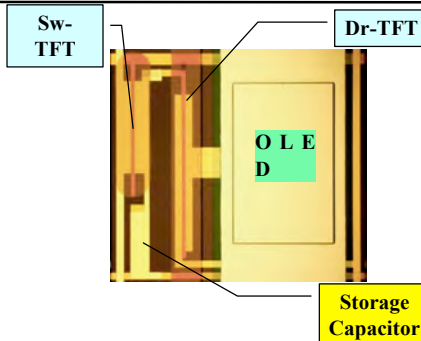
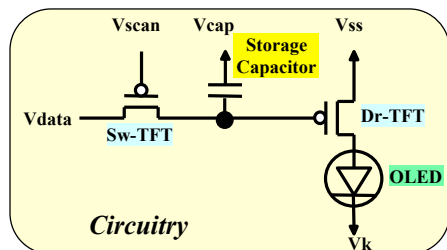
Display: 3" OTFT-TNLC
 Resolution: 64 x 128 pixels
 Pitch: 500 μm x 500 μm
 Device: 1T1C PMOS



Active-Matrix OLED: Pixel Configuration

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Schematic pixel circuit



pixel number	8 x 8
pixel pitch	1mm
aperture ratio	27%
TFT channel length	10 μm
TFT channel width	Dr-TFT:680 μm Sw-TFT:400 μm

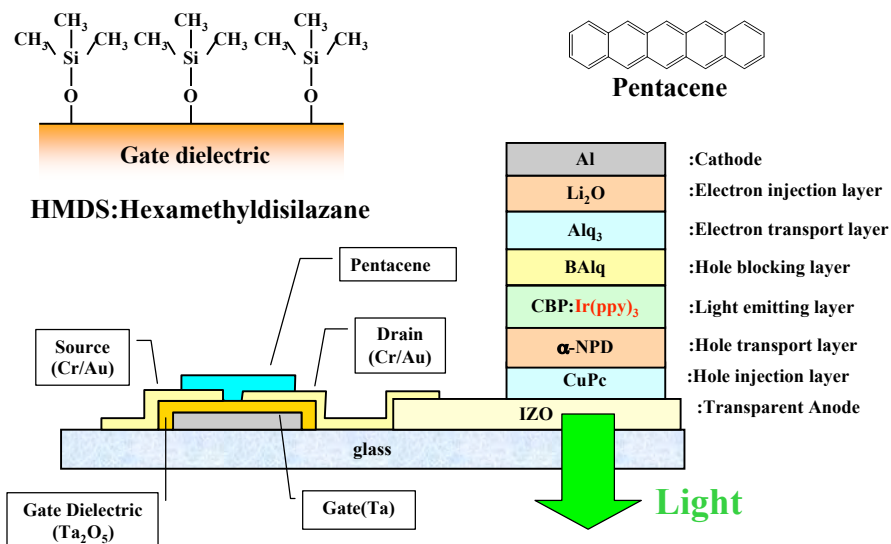
mobility	0.2 $\text{cm}^2\text{V}^{-1}\text{S}^{-1}$
threshold voltage	-3 V
on/off ratio	10 ⁵
off-current	10 ⁻⁹ A

* With HMDS treatment of gate dielectric.
 (Ta_2O_5)

Pioneer sound.vision.soul



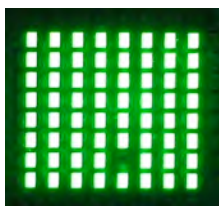
Active Matrix OLED: Cross-Section of OFET and OLED 87



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Example of OFET Active-Matrix - OLED 88



(a) Whole lighting



(b) 16 gray scales

Specification of AM OLED panel

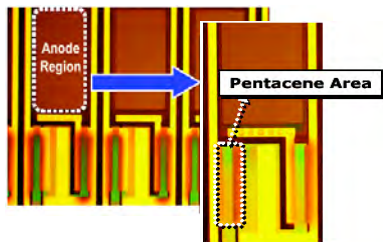
Pixel number	8 x 8
Pixel pitch	1 mm
Emission color	Green
Aperture ratio	27%
Maximum luminance	400 cd/m ²
I _{EL} per 1 pixel at L _{max}	22 μA
Frame frequency	60 Hz
Scan duty	1/60
Gray scale method	Analog 16 gray scale

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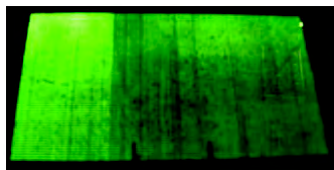
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Example of OFET Active-Matrix - OLED

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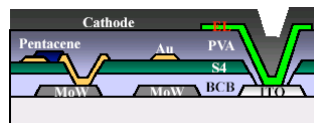


(a) Pixel Layout



(b) Display after optimization

Items		Specification
Layout	Panel size	4"
	Outer size	5" (107200um x 64225um)
	Number of pixels	64 x 3 x 120 (64x360)
	Sub-Pixel size	750 μm x 250 μm (34ppi)
	Aperture ratio	30 %
Circuit	Storage cap	1.2 pF
	Gray	Black / White
	Pixel element	2Tr_1Cap
Optical Performance	TFT size	SW: 200um/20um DR: 200um/20um
	Display color	Green mono (bottom emission)
	Full white luminance	50 cd/m ²

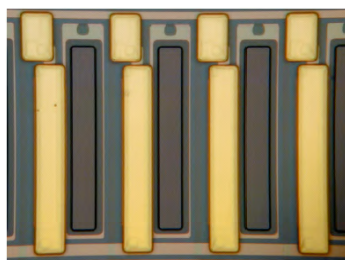


M.-C. Suh *et al.*, SID 2006, pp. 116-118, 2006.

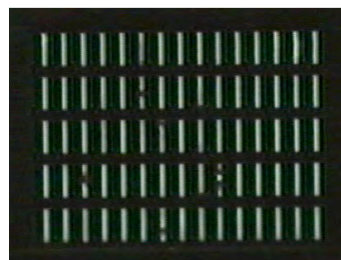


Example of OFET Active-Matrix - OLED

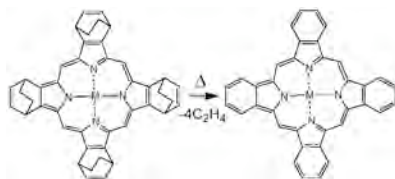
90



(a) Pixel Layout



(b) Emission of Pixel Array



(c) Tetrabenzporphyrin Molecule

Specification of AM OLED panel	
Pixel number	5 x 15
Pixel pitch	300μm x 100 μm

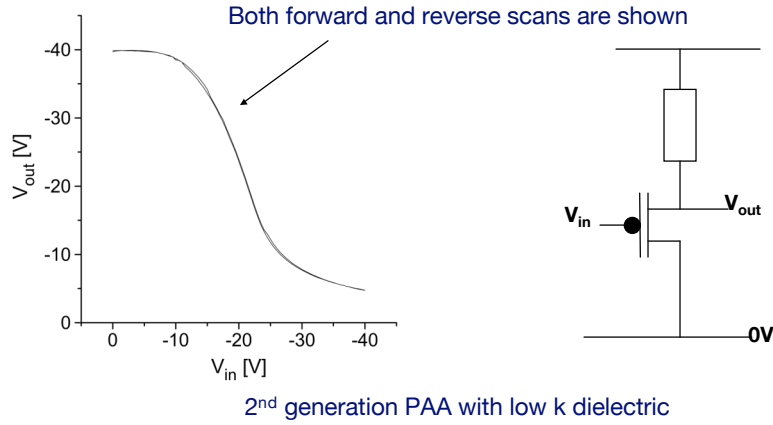


S. Aramaki *et al.*, SID 2006, L-3, 2006.



OFET-based Circuits - Inverters

91



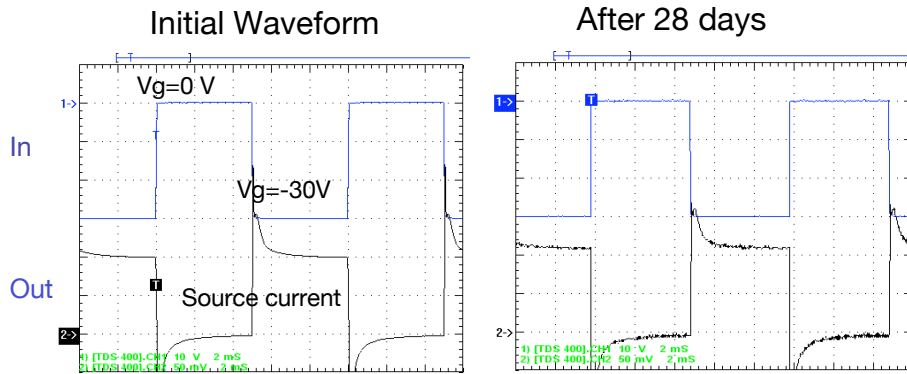
COVION Avecia

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OFET-based Circuits - Inverters (2)

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Inverter circuits can be environmentally stable after prolonged exposure and operation.



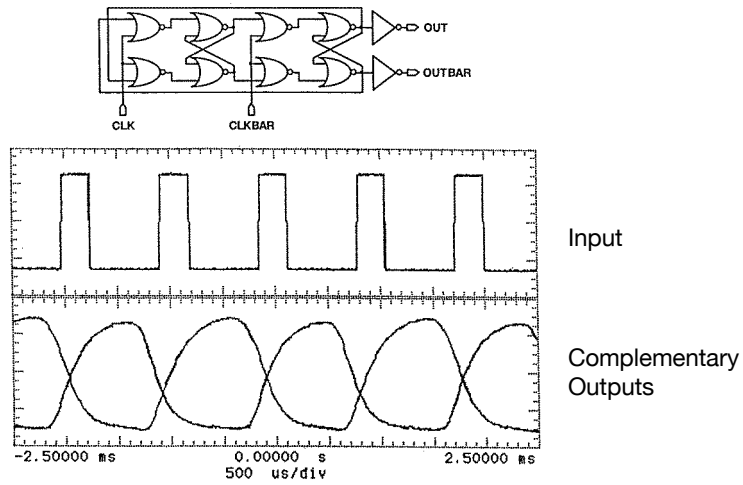
- 100 Hz signal 0 to -30V signal applied to the gate
- Source current is monitored with a current feedback amplifier
- Turn-on time is comparable to accumulation time for a 130 μm channel

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OFET-based Circuits - Frequency Divider

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M. Kane et al., *IEEE EDL*, **21**, 534-536 (2000).

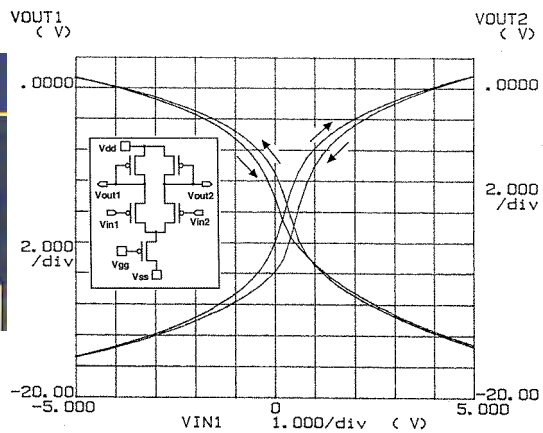
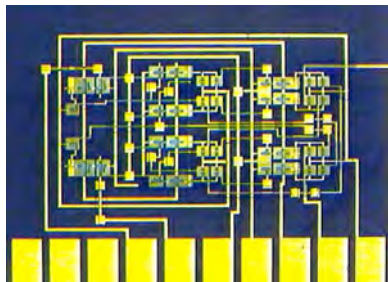
- 48 transistors
- Operation at 1.1 kHz
- 65% functional yield



OFET-based Circuits - Differential Amplifier

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- Voltage gain = -5 to -10
- Offset voltage = -1V to +1V

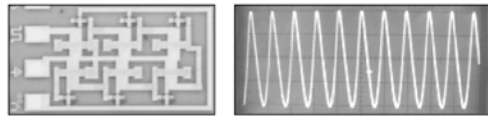
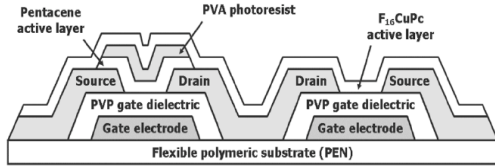


Kane et al., *IEEE EDL*, **21**, 534-536 (2000).



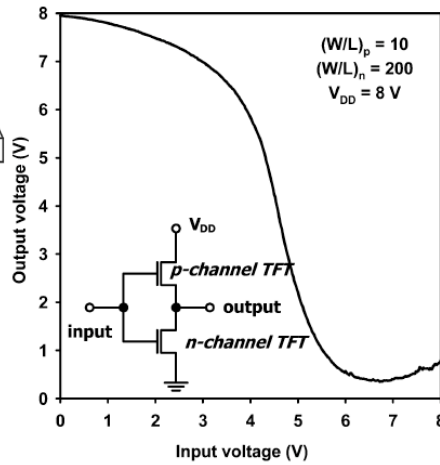
OFET-based Circuits - Ring Oscillators

95



Requires both P- and N-type OFETs.

H. Klauk et al., *IEEE T-ED*, **52**, 618-622 (2005).

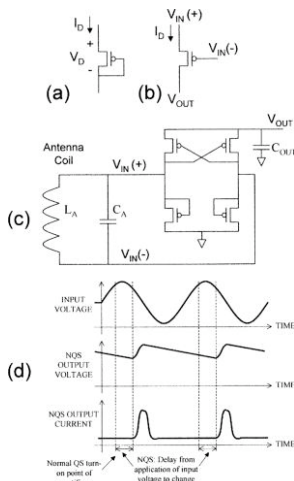


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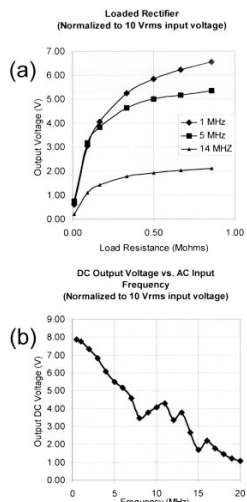
OFET-based Circuits - RF-ID Tags

96

• Circuits oscillating at radio frequency (13.67 MHz) have been demonstrated.



R. Rotzroll et al., *Appl. Phys. Lett.*, **88**, 123502 (2006).



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Topics relevant, but not covered, in this presentation:

- OLEDs / PLEDs
- Solar cells
- Chemical sensors
- Image sensors
- Lasers
- Memory and storage
- X-ray and gamma ray sensors
- Advanced pixel electrode circuits for AM-OLEDs
- Driving electronics

- Organic thin-film field-effect transistors (OFETs) can be fabricated using:
 - Many different device structures
 - By solid- or solution-processing
 - With a wide variety of materials suitable for various applications.
- Many aspects of OFET physics are not well understood, but are close to being solved.
- In other respects, OFETs behave much like c-Si MOSFETs.
- OFETs have been shown to be suitable for:
 - Large-area, full-color displays
 - RF-ID circuits
 - Logic circuits
 - Chemical sensors
 - Light-emitters and detectors

Conclusions (2)

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- **Problems to be addressed:**
 - **Electrical stability**
 - **Processing stability**
 - **Low-cost fabrication**
 - **Packaging**
 - **Etching**
 - **Impurities**
 - **Etc.**
- **It may take several years for practical products to be brought to market.**
- **Potential payoff could be very large...billions?**



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